



US00D823278S

(12) **United States Design Patent**
Ito et al.

(10) **Patent No.:** **US D823,278 S**
(45) **Date of Patent:** **** Jul. 17, 2018**

(54) **HEADPHONE**

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(73) Assignee: **SONY CORPORATION**, Tokyo (JP)

(**) Term: **14 Years**

(21) Appl. No.: **29/465,753**

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(51) **LOC (11) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
USPC D14/205, 206, 223; 181/129, 130, 135;
379/430, 431; 381/380, 381, 374, 375,
(Continued)

(56) **References Cited**

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Primary Examiner — Paula Allen Greene

(74) *Attorney, Agent, or Firm* — Michael Best and Friedrich LLP

(57) **CLAIM**

The ornamental design for a headphone, as shown.

DESCRIPTION

FIG. 1 is a perspective view of a first embodiment of a headphone showing our new design;

FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left side elevational view thereof;
FIG. 5 is a top plan view thereof; and
FIG. 6 is a bottom plan view thereof.
FIG. 7 is a perspective view thereof wherein the headphone housing is in a first alternate position;
FIG. 8 is a perspective view thereof wherein the headphone housing is in a second alternate position;
FIG. 9 is a perspective view thereof wherein the headphone housing is in a third alternate position;
FIG. 10 is a perspective view thereof wherein the headphone housing is in a fourth alternate position;
FIG. 11 is a rear elevational view thereof wherein the headphone housing is in the first alternate position;
FIG. 12 is a rear elevational view thereof wherein the headphone housing is in the second alternate position; and
FIG. 13 is a rear elevational view thereof wherein the headphone housing is in the third alternate position.
FIG. 14 is a rear elevational view thereof wherein the headphone housing is in the fourth alternate position.
FIG. 15 is a perspective view of a second embodiment of a headphone showing our new design;
FIG. 16 is a front elevational view thereof;
FIG. 17 is a rear elevational view thereof;
FIG. 18 is a left side elevational view thereof;
FIG. 19 is a top plan view thereof; and
FIG. 20 is a bottom plan view thereof.
FIG. 21 is a perspective view thereof wherein the headphone housing is in a first alternate position;
FIG. 22 is a perspective view thereof wherein the headphone housing is in a second alternate position;
FIG. 23 is a perspective view thereof wherein the headphone housing is in a third alternate position;
FIG. 24 is a perspective view thereof wherein the headphone housing is in a fourth alternate position;
FIG. 25 is a rear elevational view thereof wherein the headphone housing is in the first alternate position;
FIG. 26 is a rear elevational view thereof wherein the headphone housing is in the second alternate position;
FIG. 27 is a rear elevational view thereof wherein the headphone housing is in the third alternate position; and

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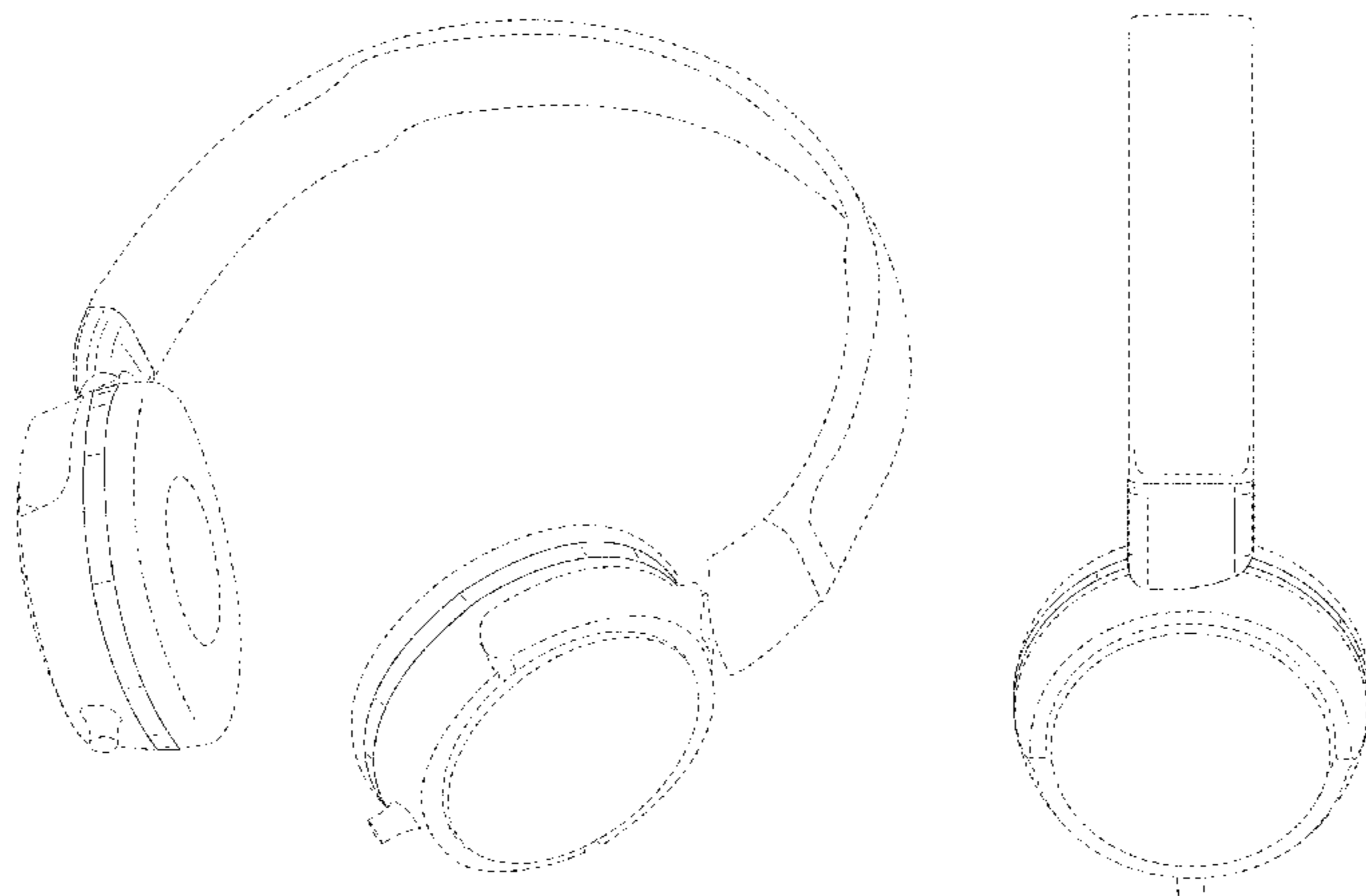


FIG. 28 is a rear elevational view thereof wherein the headphone housing is in the fourth alternate position.
 FIG. 29 is a perspective view of a third embodiment of a headphone showing our new design;
 FIG. 30 is a front elevational view thereof;
 FIG. 31 is a rear elevational view thereof;
 FIG. 32 is a left side elevational view thereof;
 FIG. 33 is a top plan view thereof; and
 FIG. 34 is a bottom plan view thereof.
 FIG. 35 is a perspective view thereof wherein the headphone housing is in a first alternate position;
 FIG. 36 is a perspective view thereof wherein the headphone housing is in a second alternate position;
 FIG. 37 is a perspective view thereof wherein the headphone housing is in a third alternate position;
 FIG. 38 is a perspective view thereof wherein the headphone housing is in a fourth alternate position;
 FIG. 39 is a rear elevational view thereof wherein the headphone housing is in the first alternate position;
 FIG. 40 is a rear elevational view thereof wherein the headphone housing is in the second alternate position;
 FIG. 41 is a rear elevational view thereof wherein the headphone housing is in the third alternate position; and
 FIG. 42 is a rear elevational view thereof wherein the headphone housing is in the fourth alternate position.
 FIG. 43 is a right side elevational view of the embodiment of FIG. 1;
 FIG. 44 is a right side elevational view of the embodiment of FIG. 15; and,
 FIG. 45 is a right side elevational view of the embodiment of FIG. 29.
 The broken lines illustrating unclaimed portions of the headphone form no part of the claimed design. Dot-dash broken lines illustrating boundaries of the claimed design form no part of the claimed design.

1 Claim, 42 Drawing Sheets

(58) **Field of Classification Search**
 USPC 381/74; 455/90.3, 575.1; D29/112;
 2/209
 CPC H04R 1/1066; H04R 1/1016; H04R 25/00;
 H04R 1/10; H04R 5/0335; H04R 5/033
 See application file for complete search history.

(56)

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FIG.1

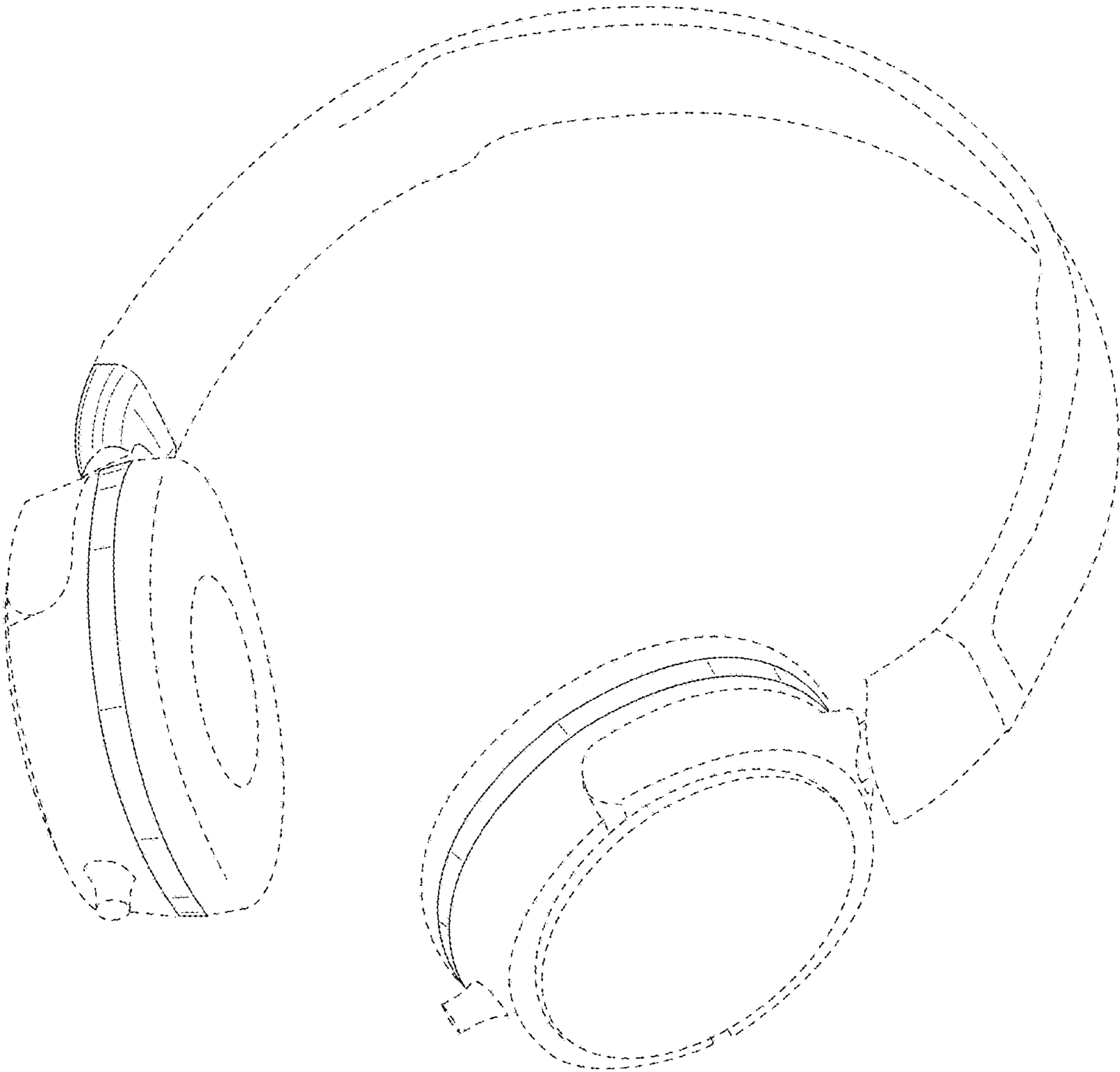


FIG.2

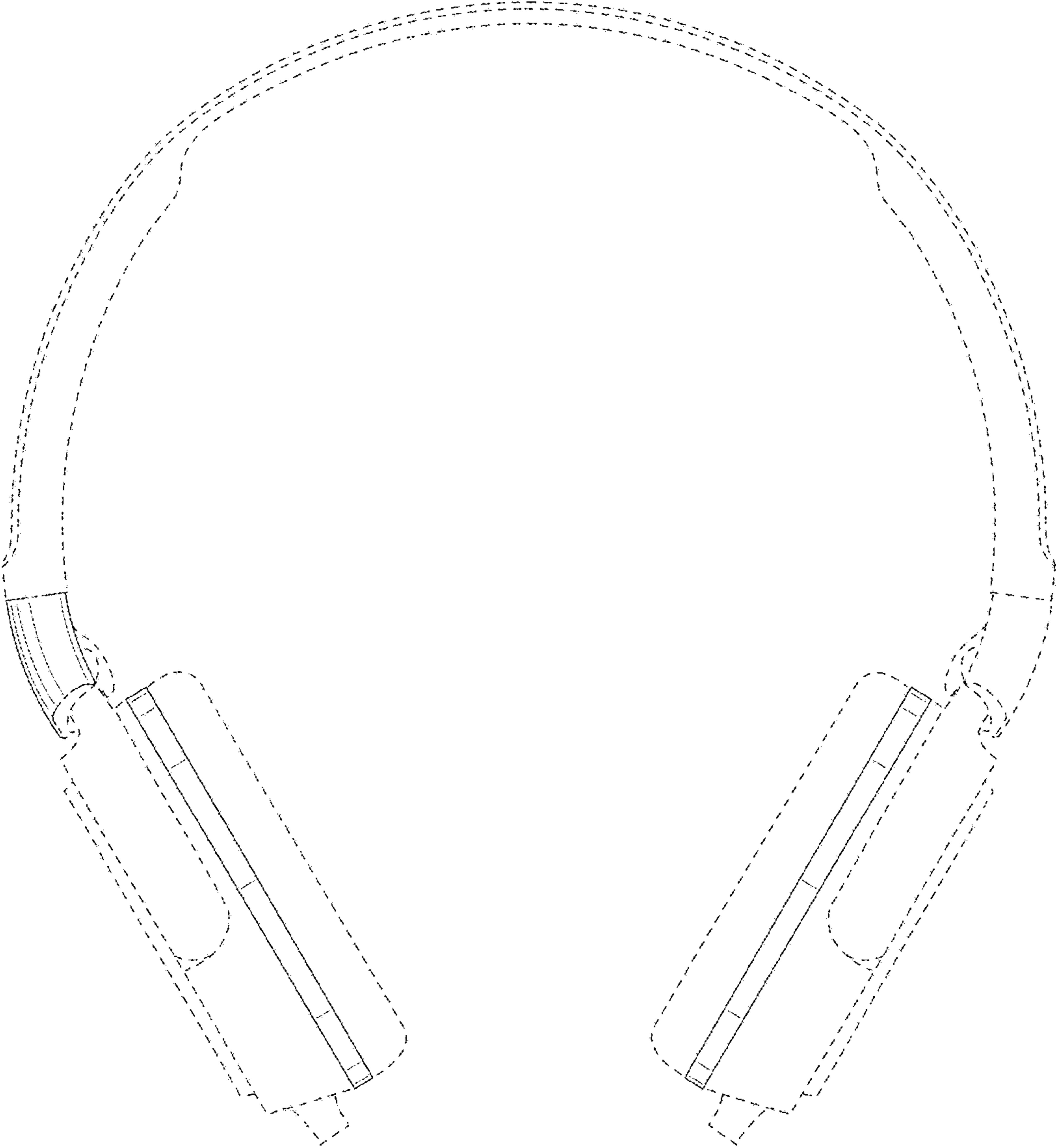


FIG.3

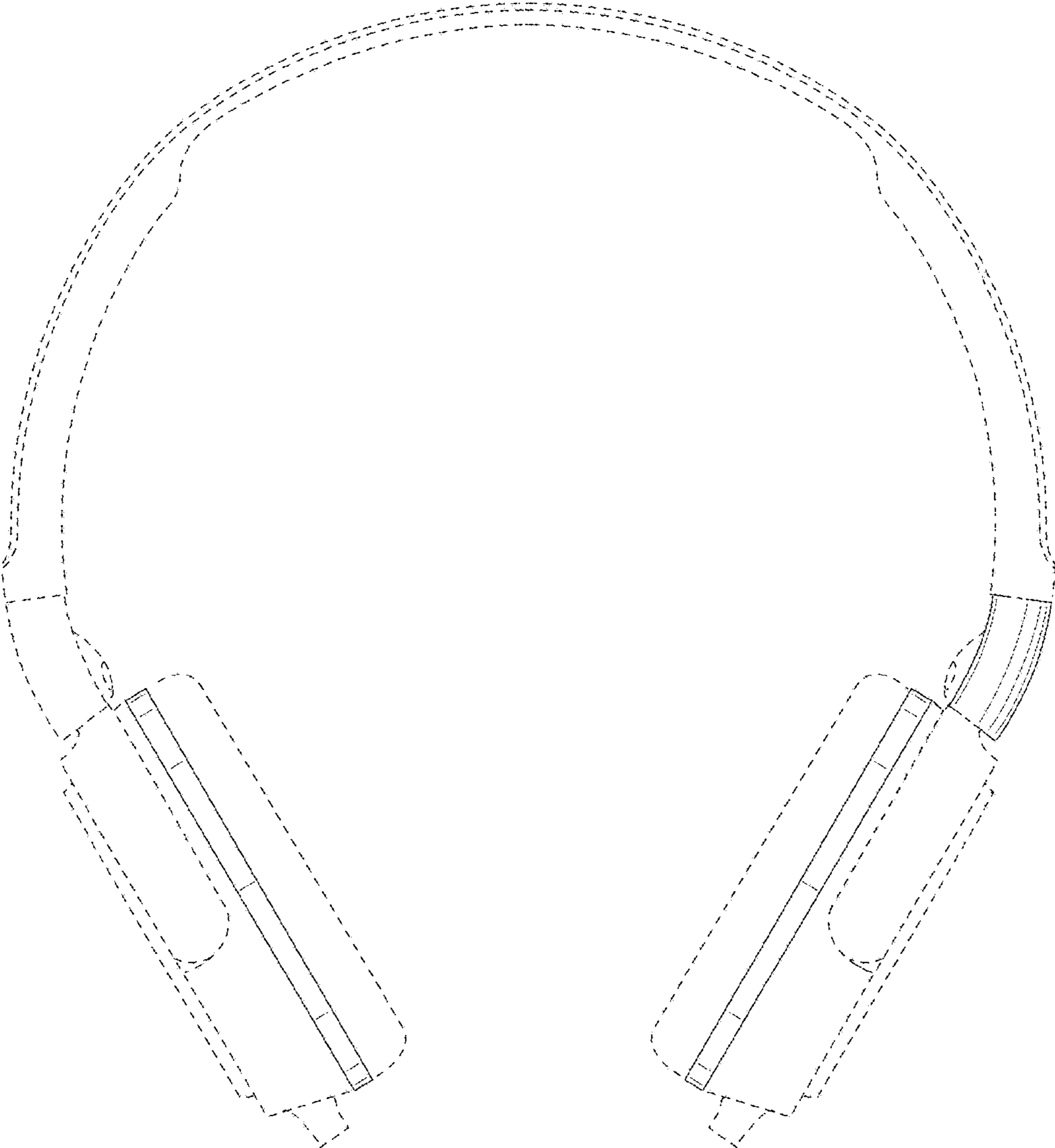


FIG.4

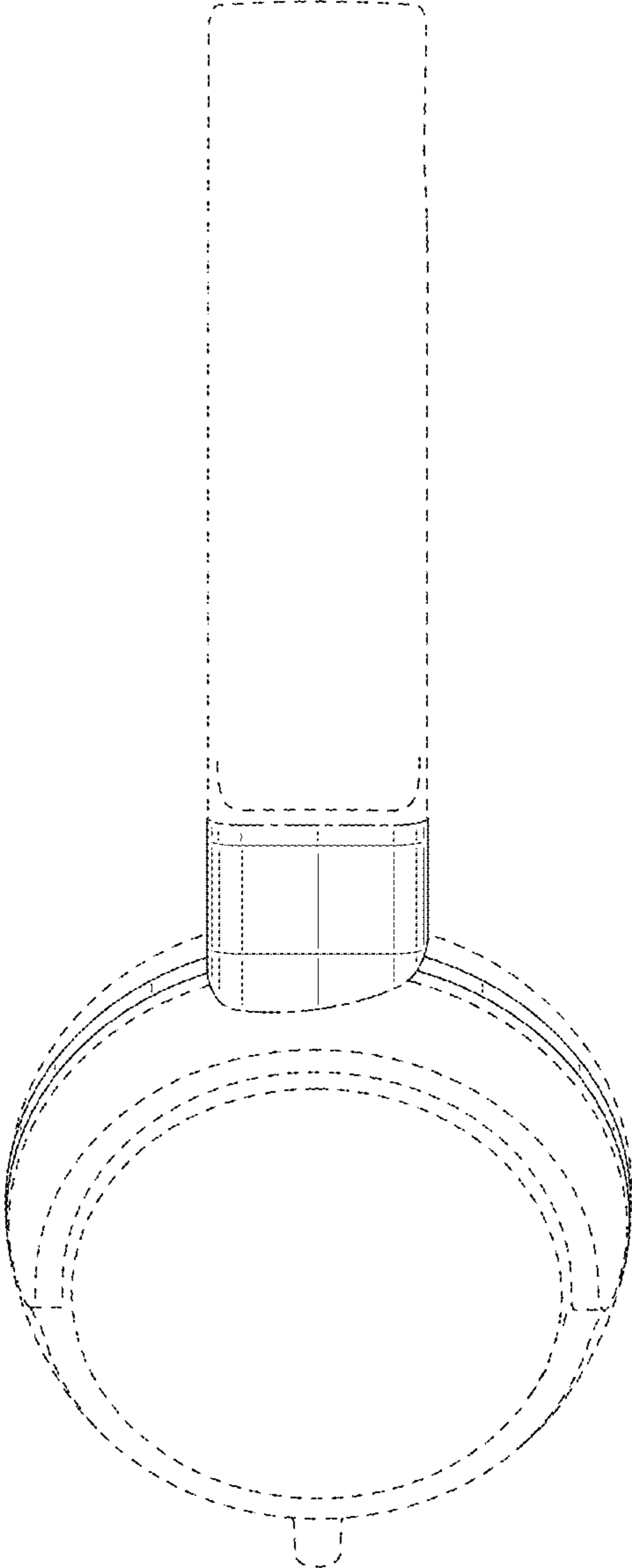


FIG.5

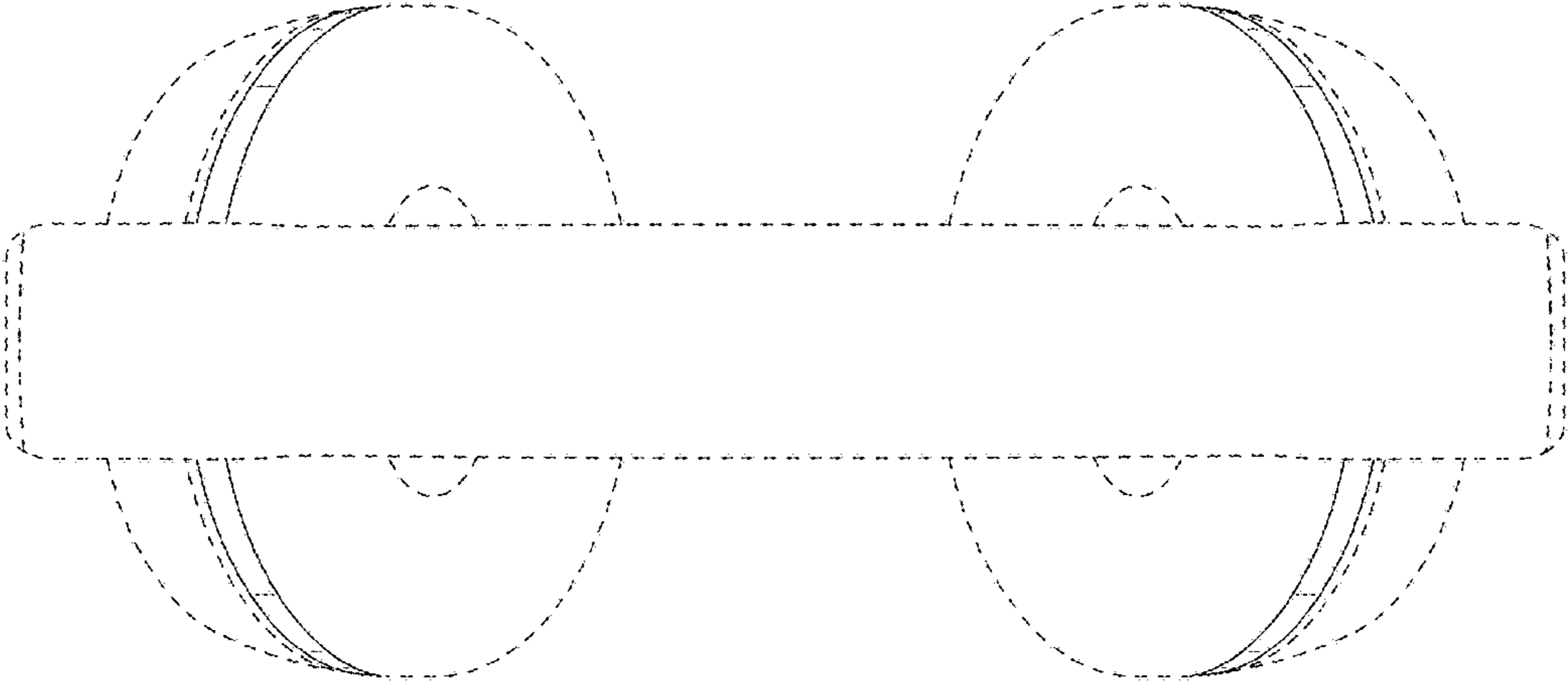


FIG.6

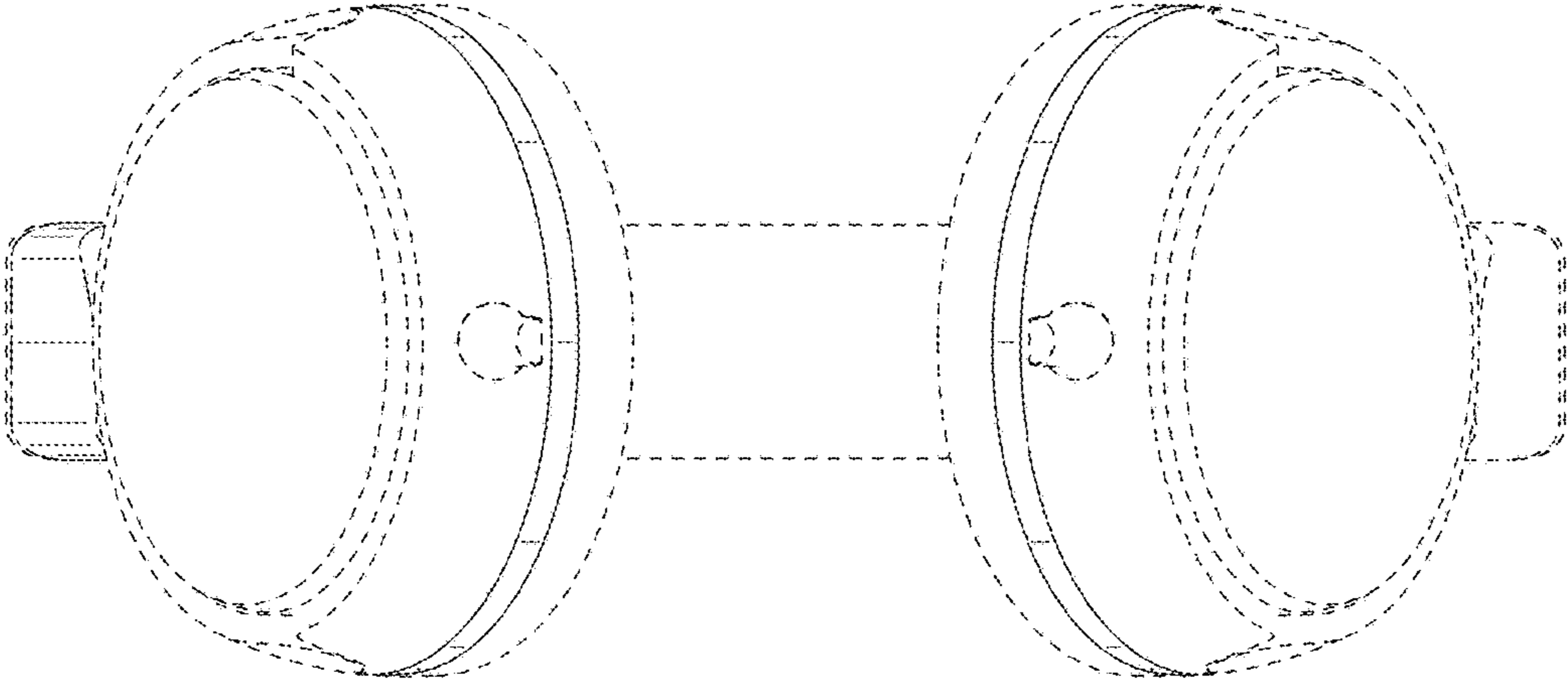


FIG.7

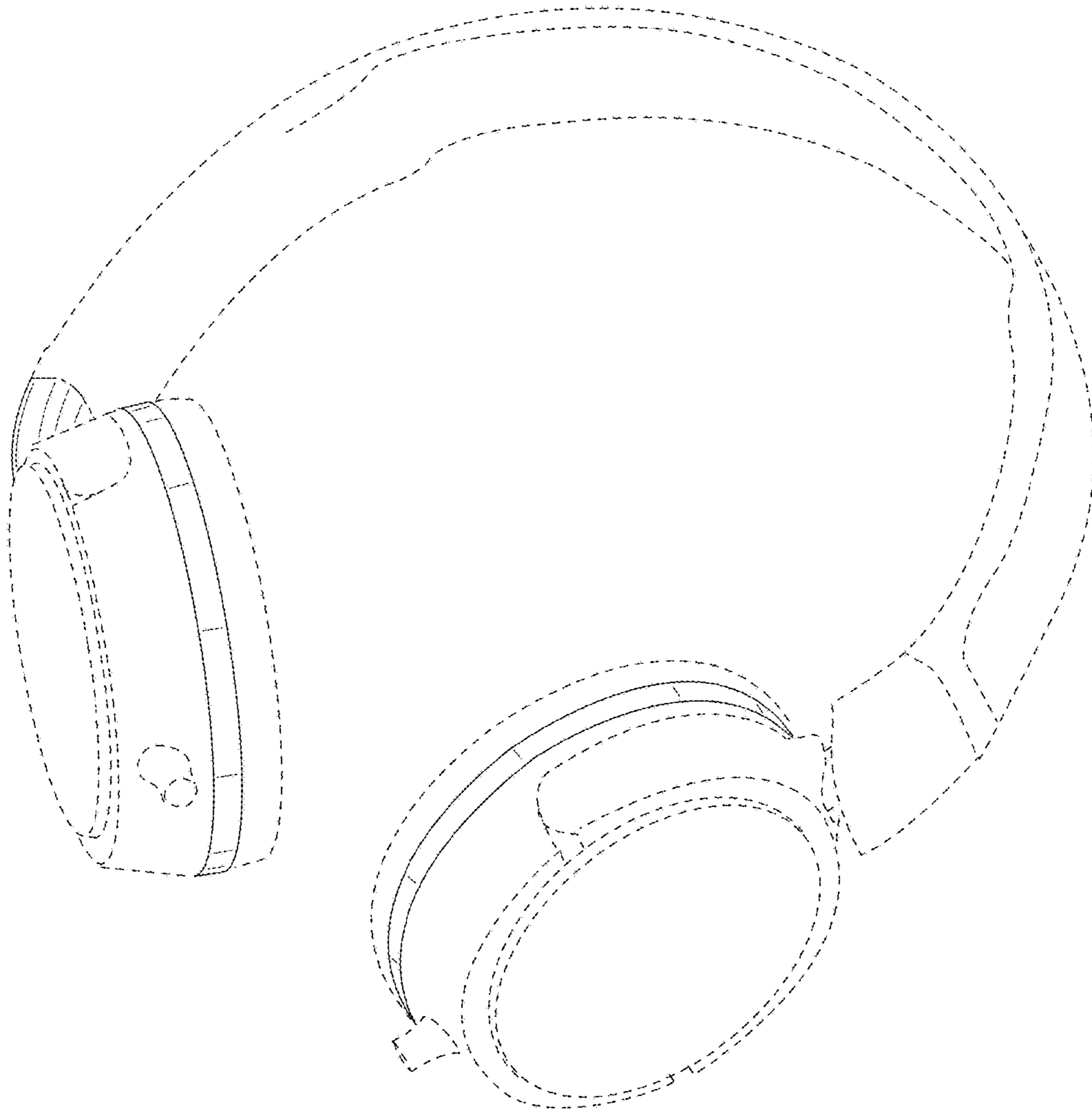


FIG.8

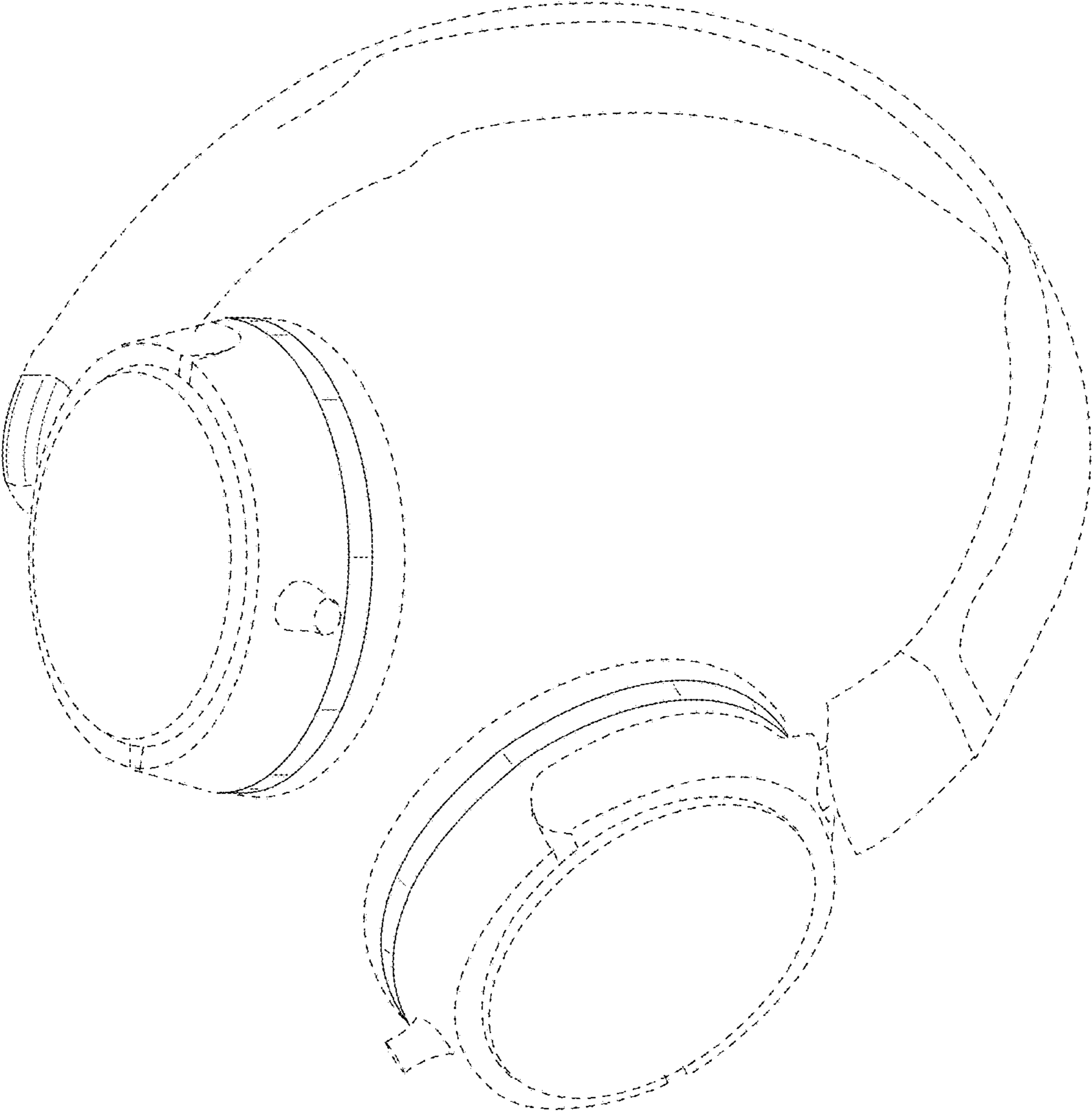


FIG.9

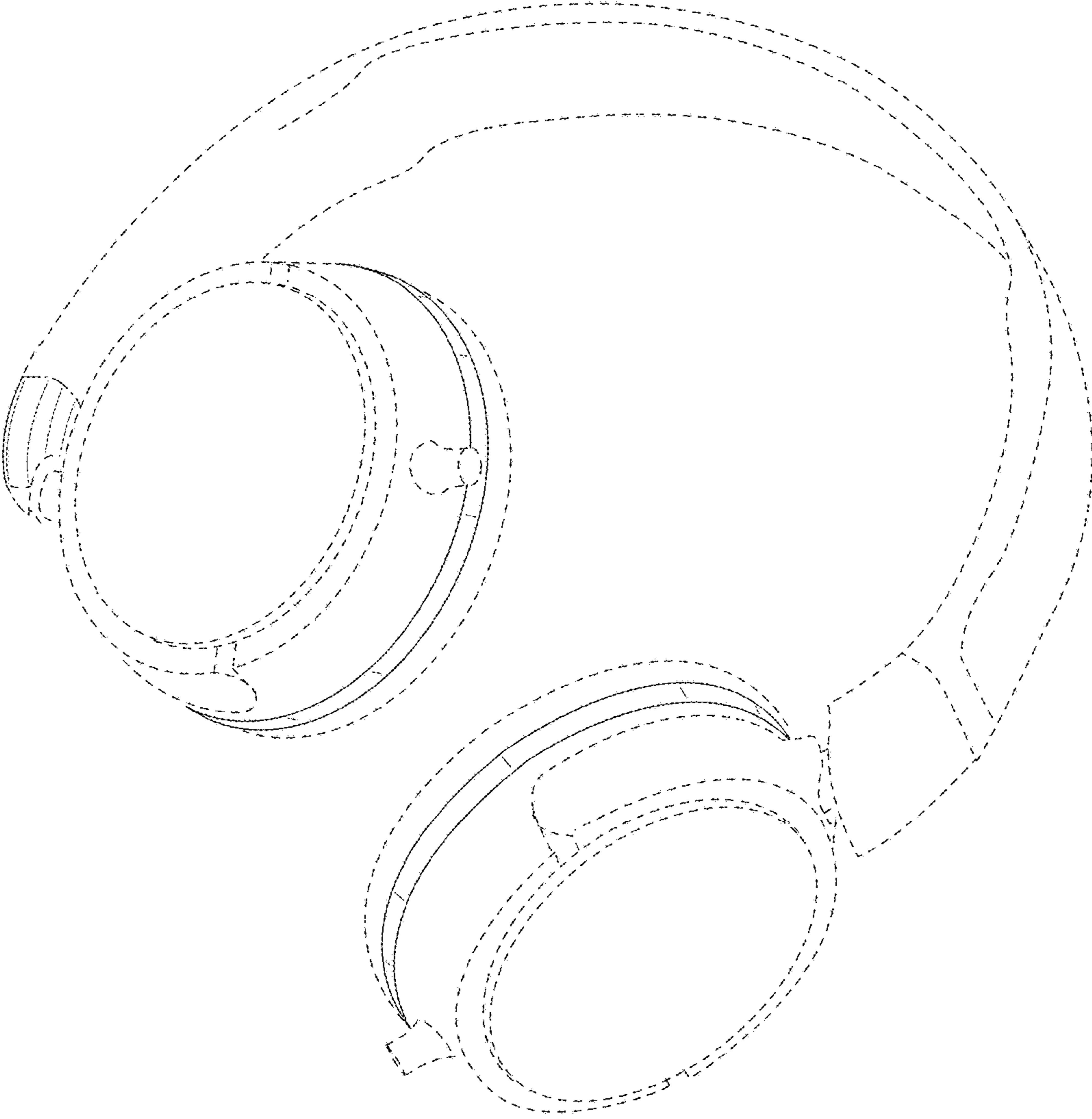


FIG.10

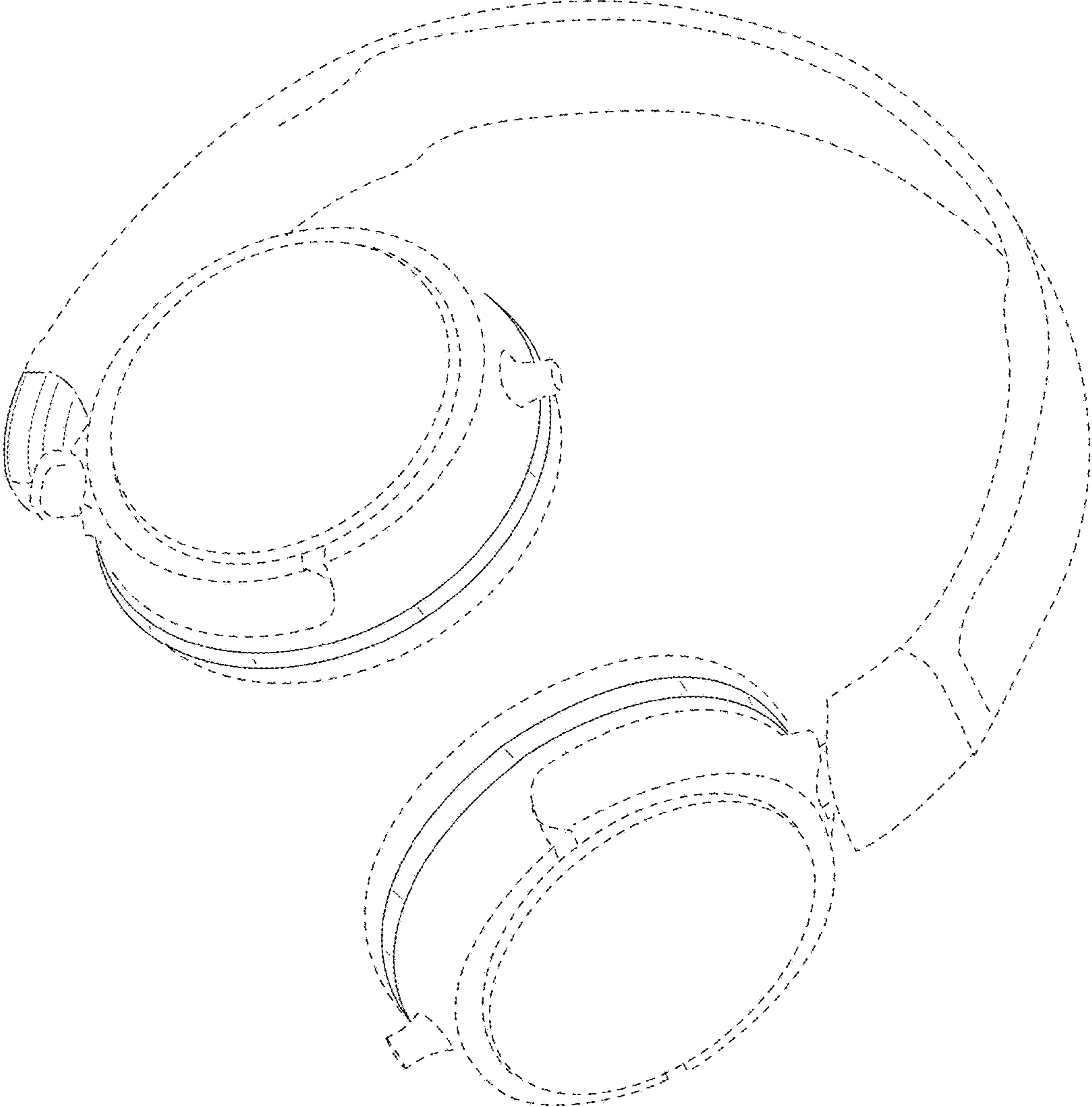


FIG. 11



FIG.12

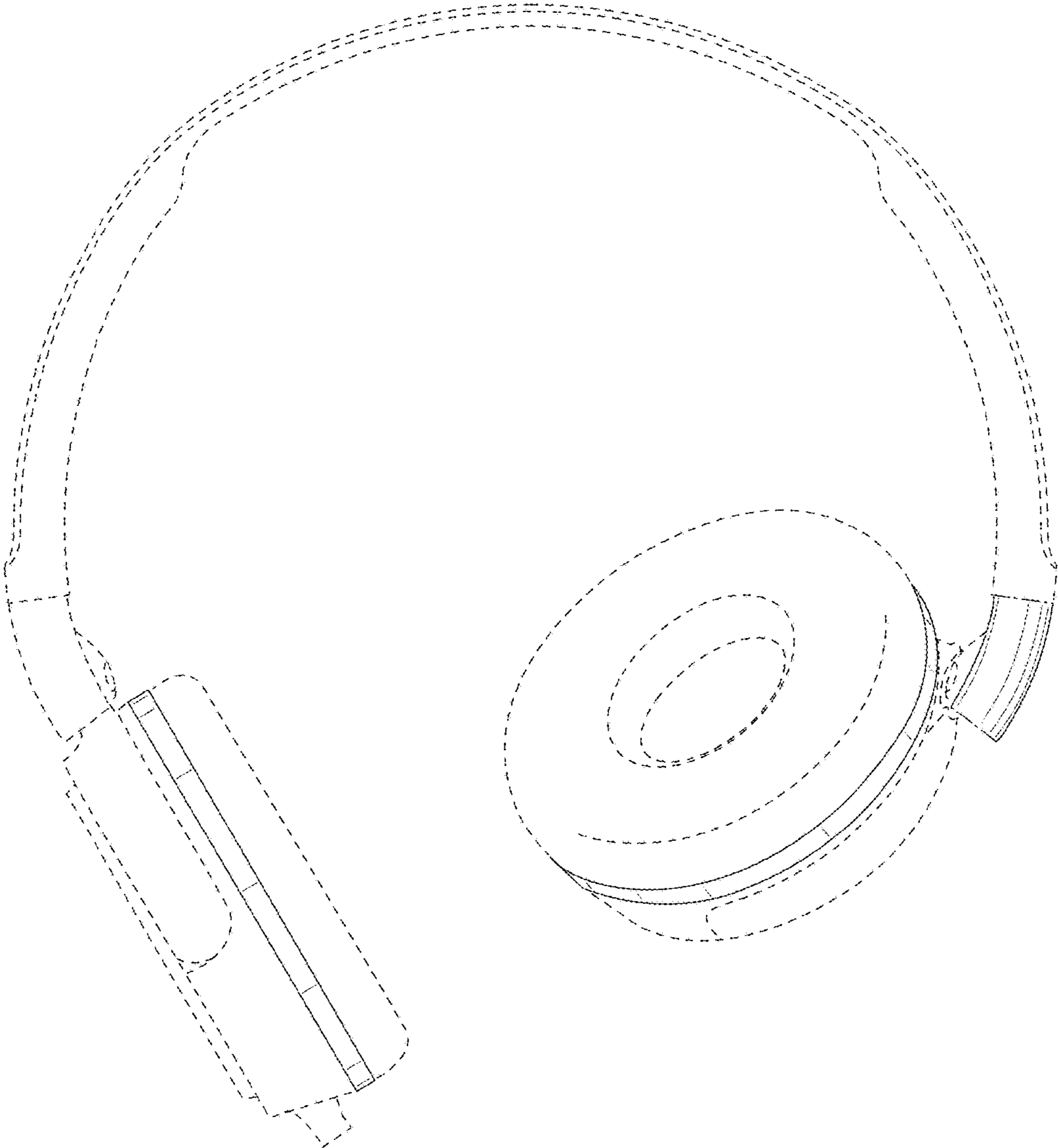


FIG.13

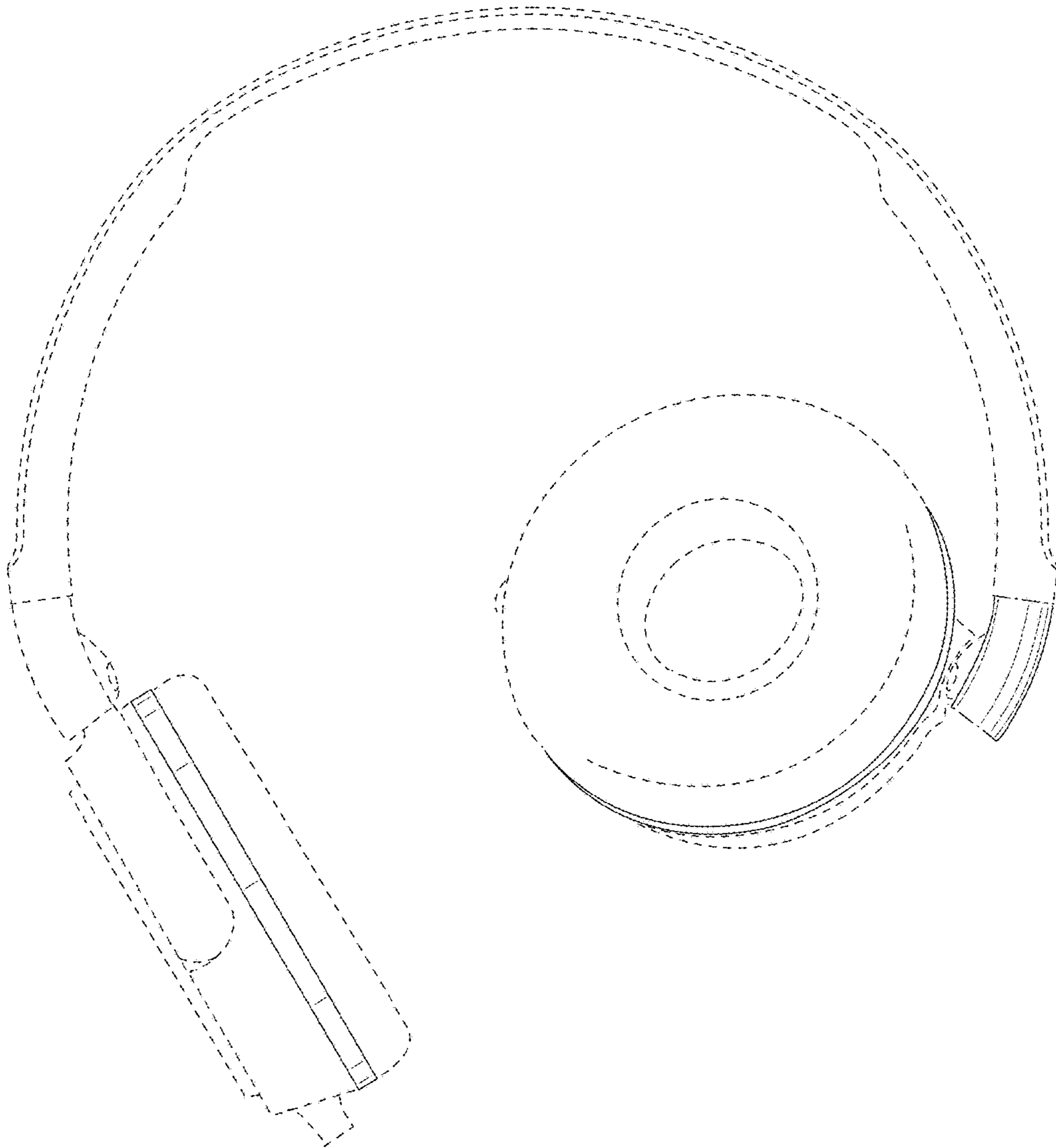


FIG.14

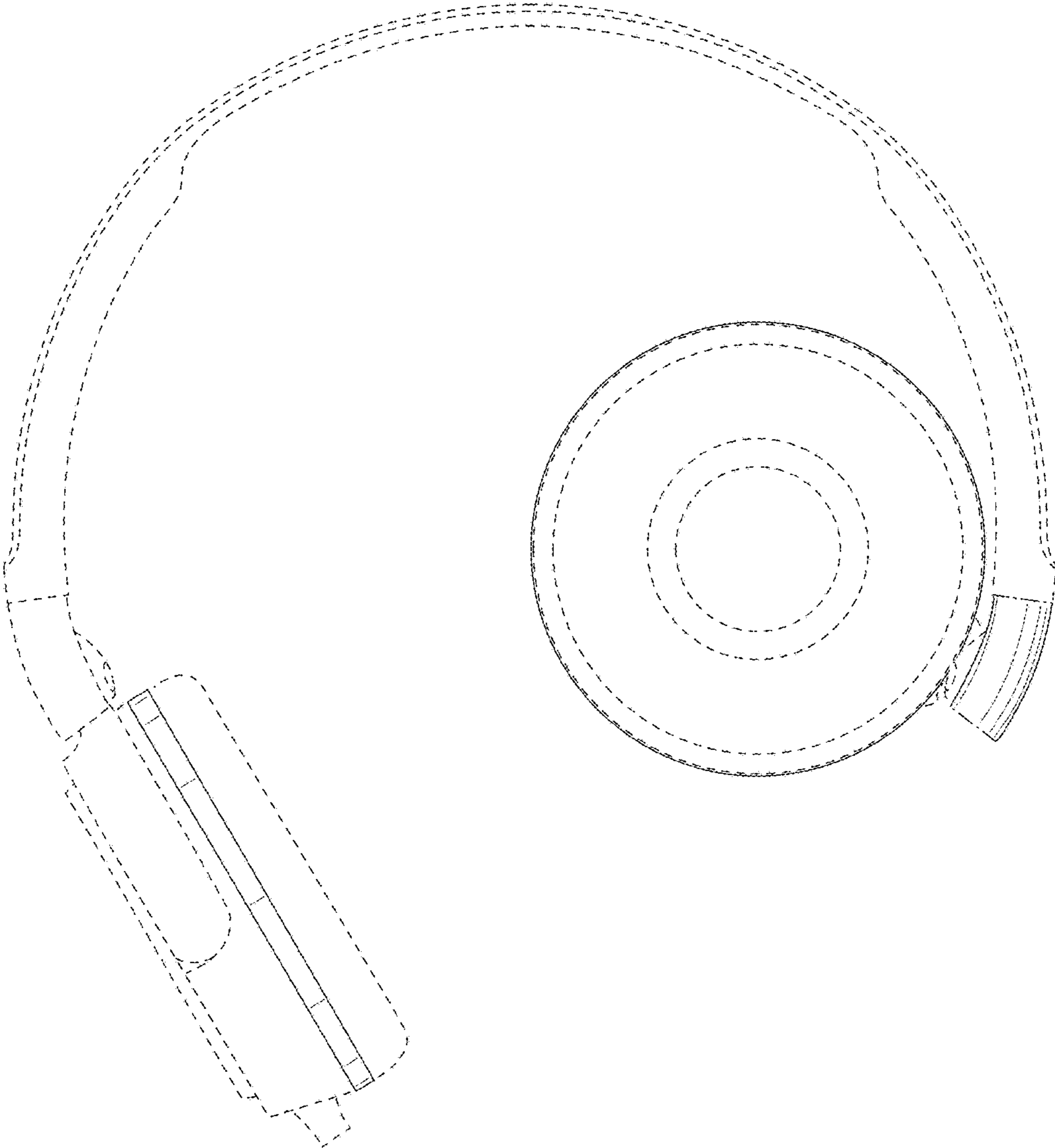


FIG.15

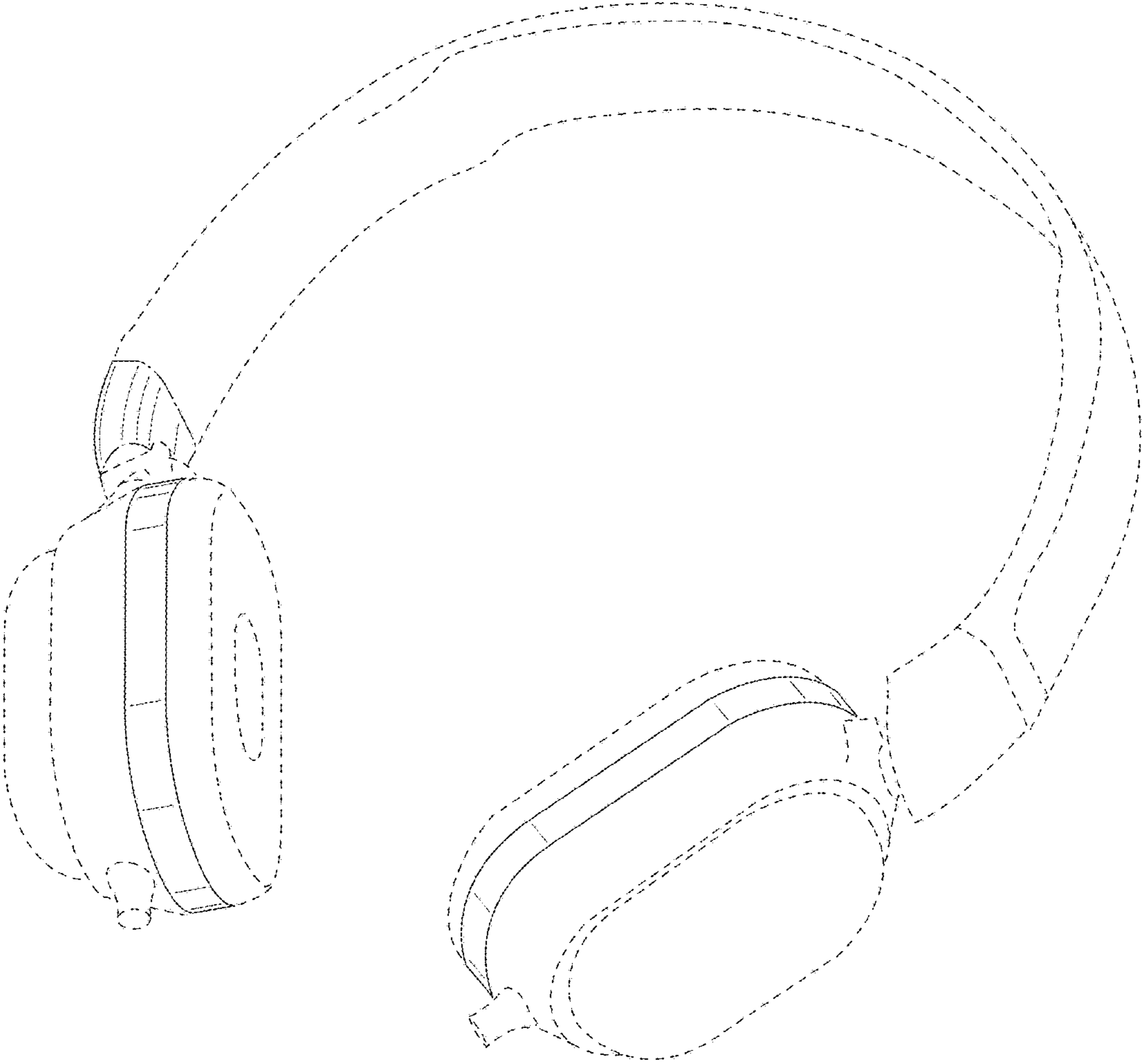


FIG.16

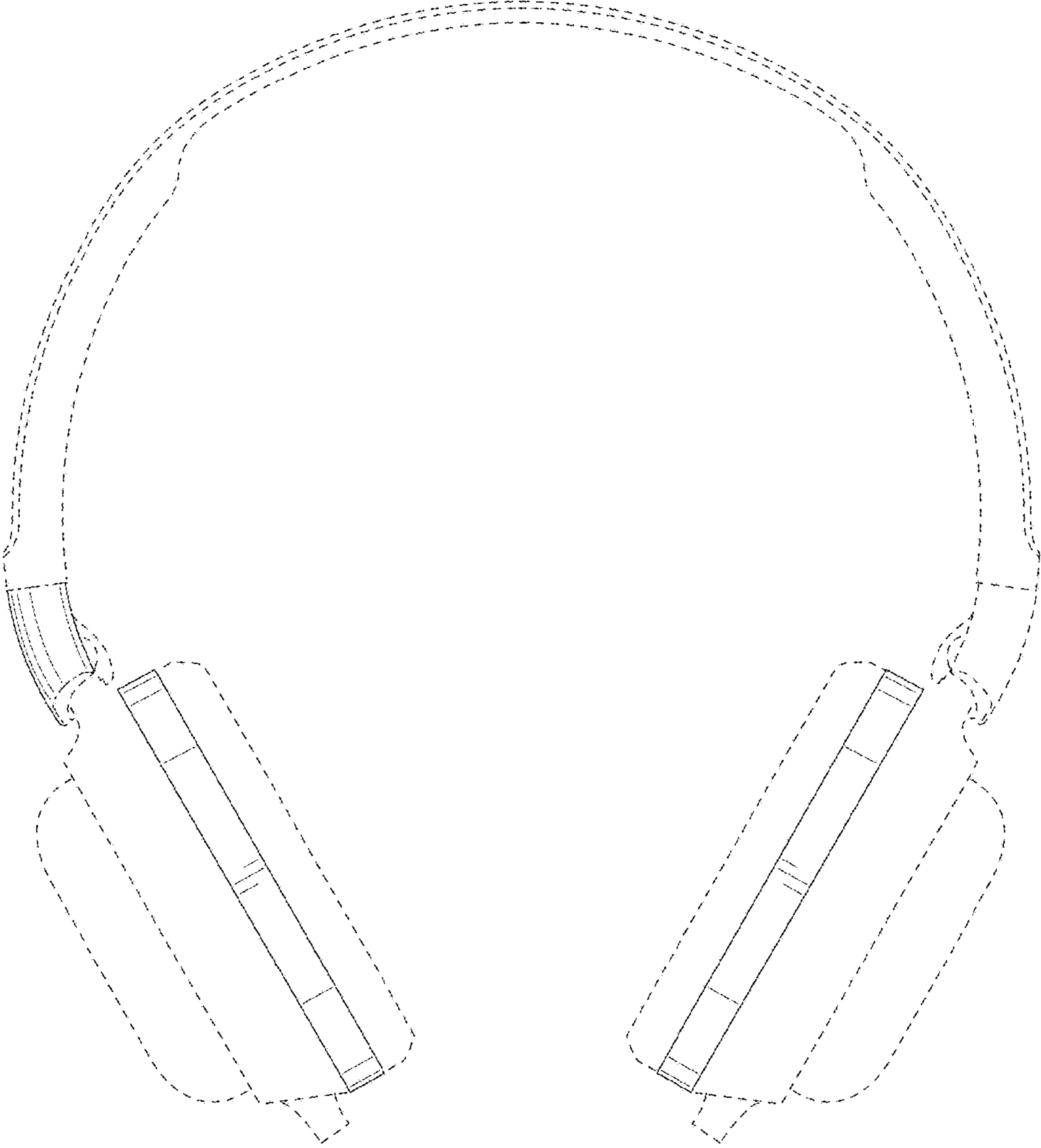


FIG.17

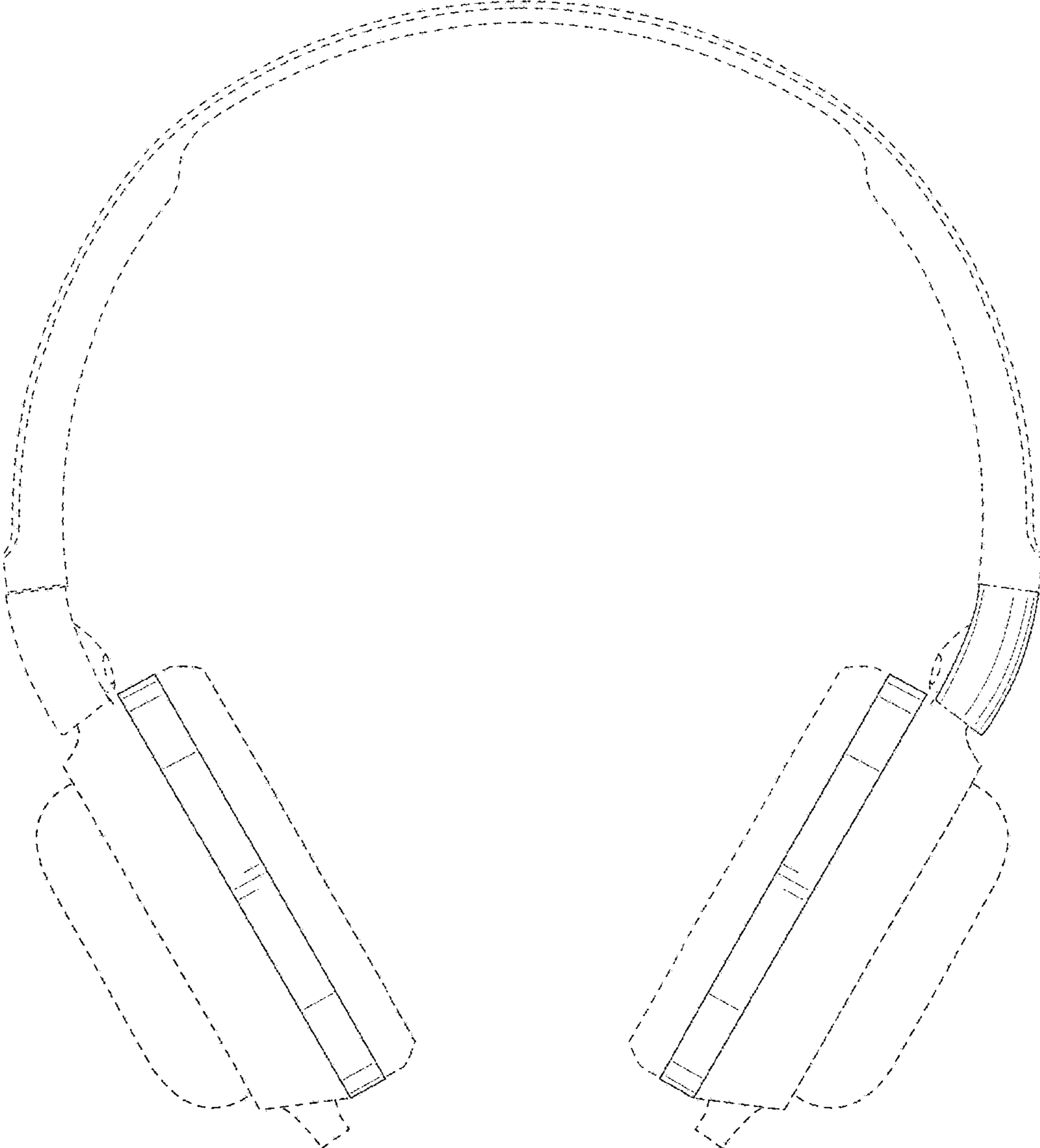


FIG.18

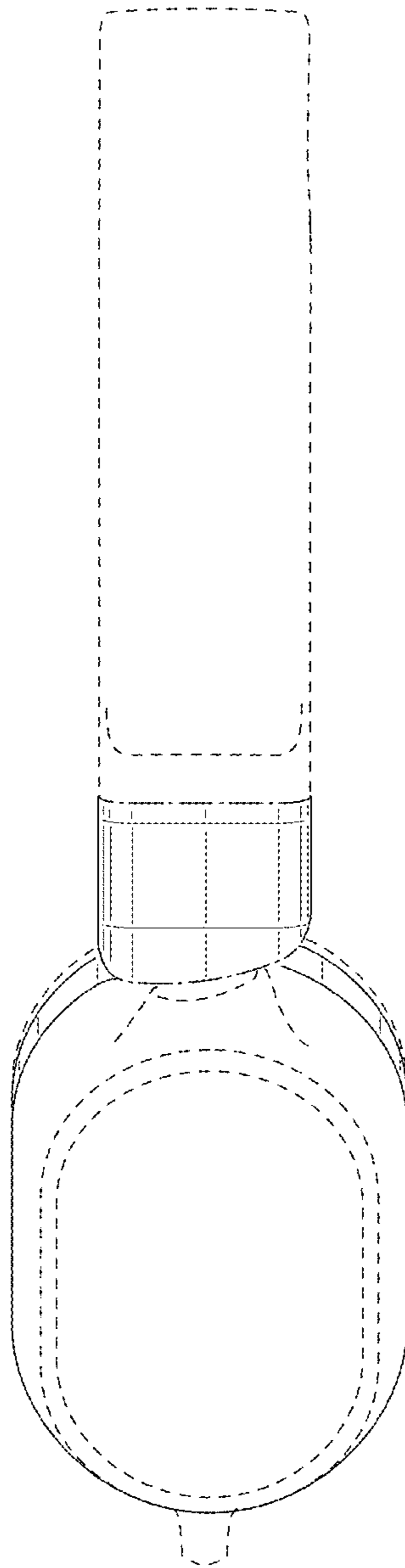


FIG.19

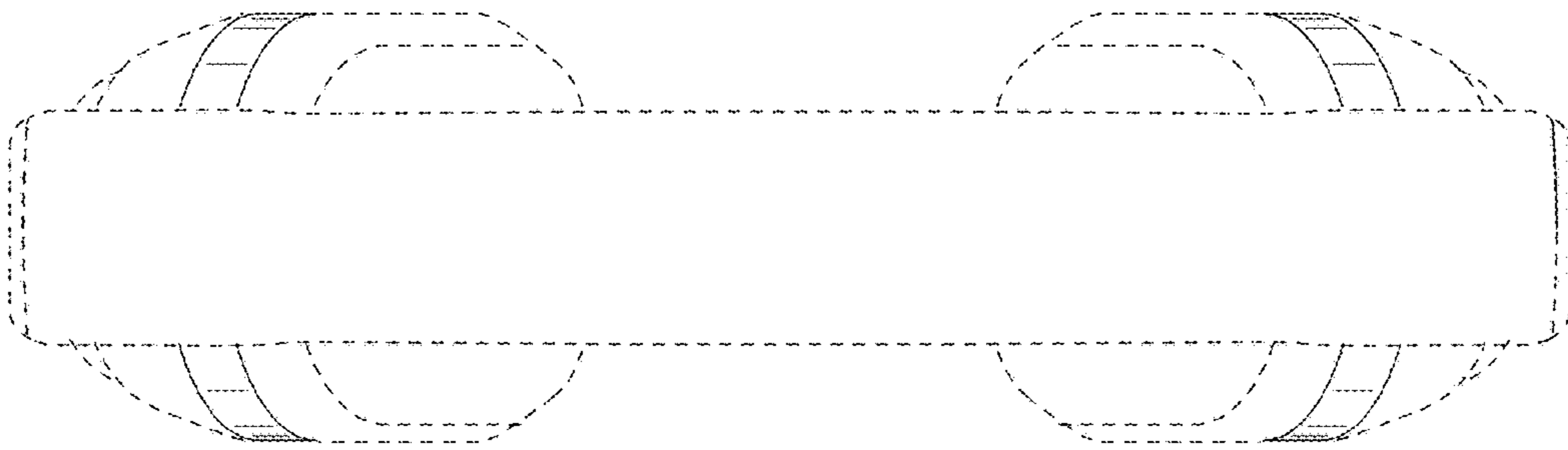


FIG.20

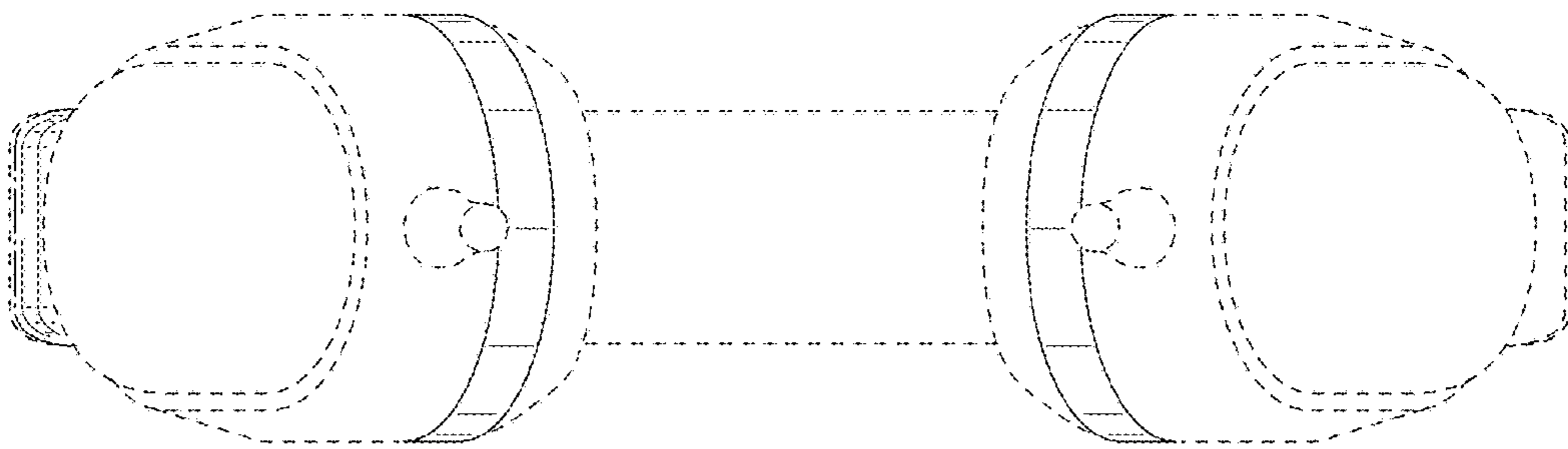


FIG.21



FIG.22

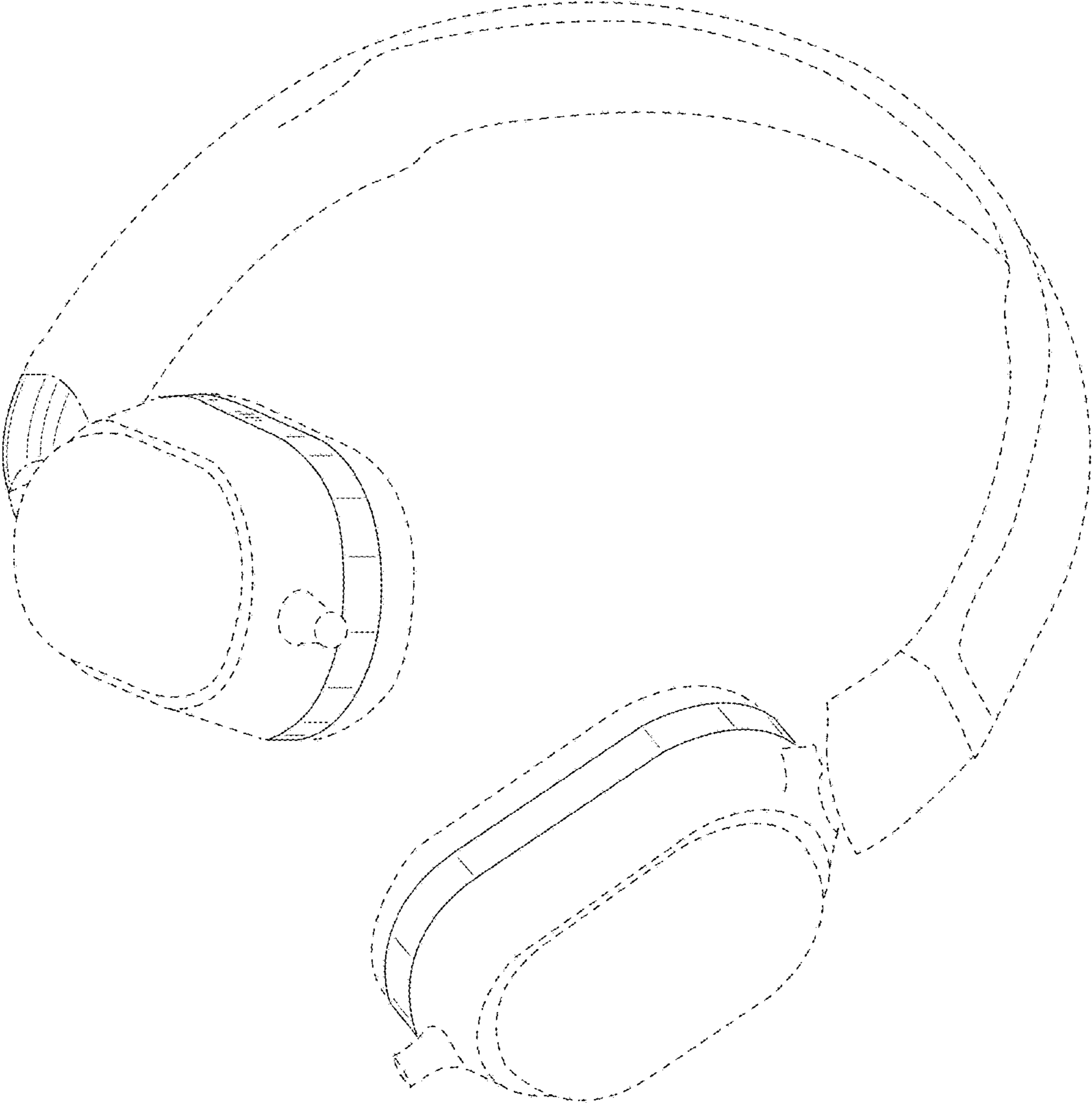


FIG.23

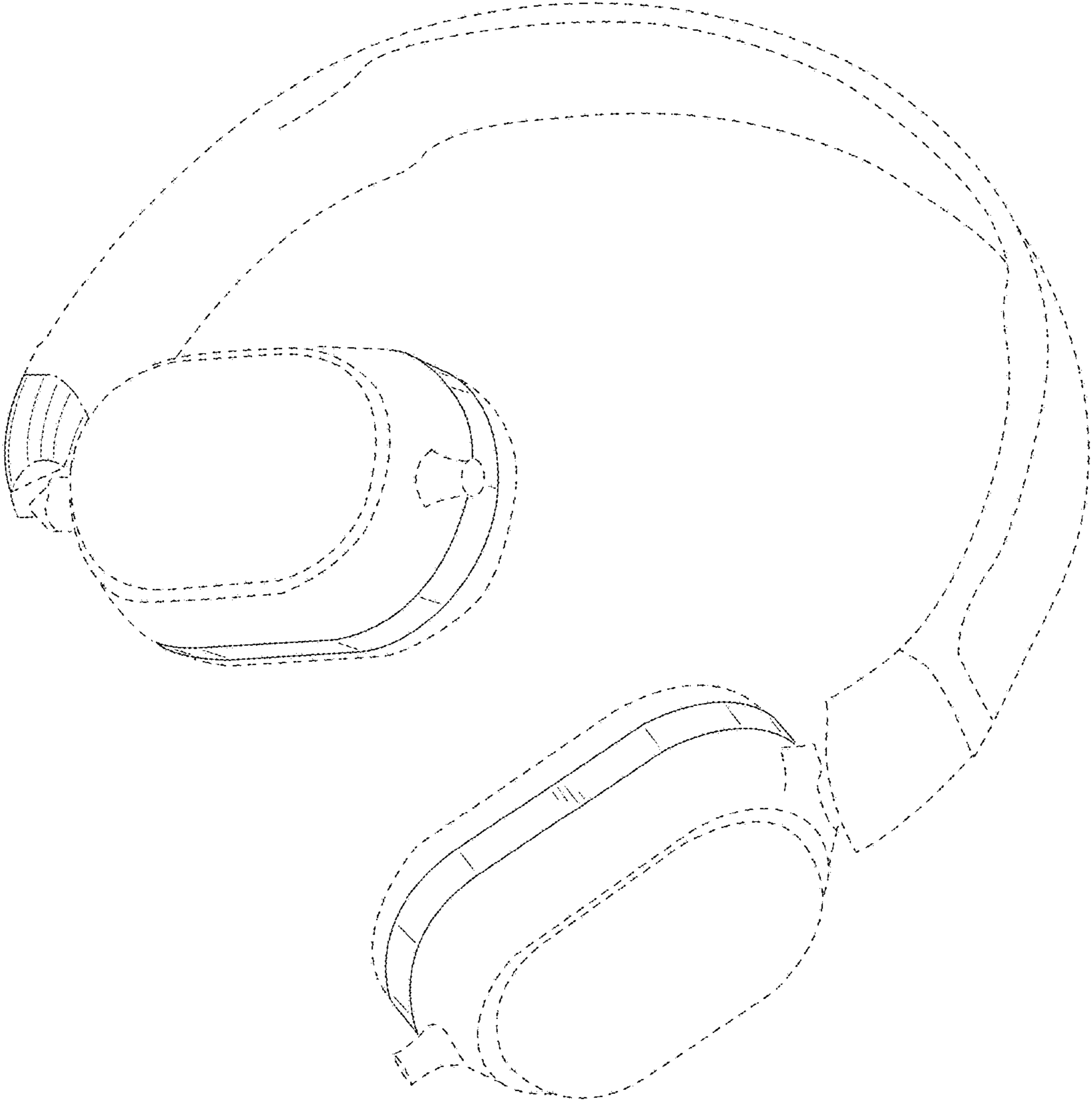


FIG.24

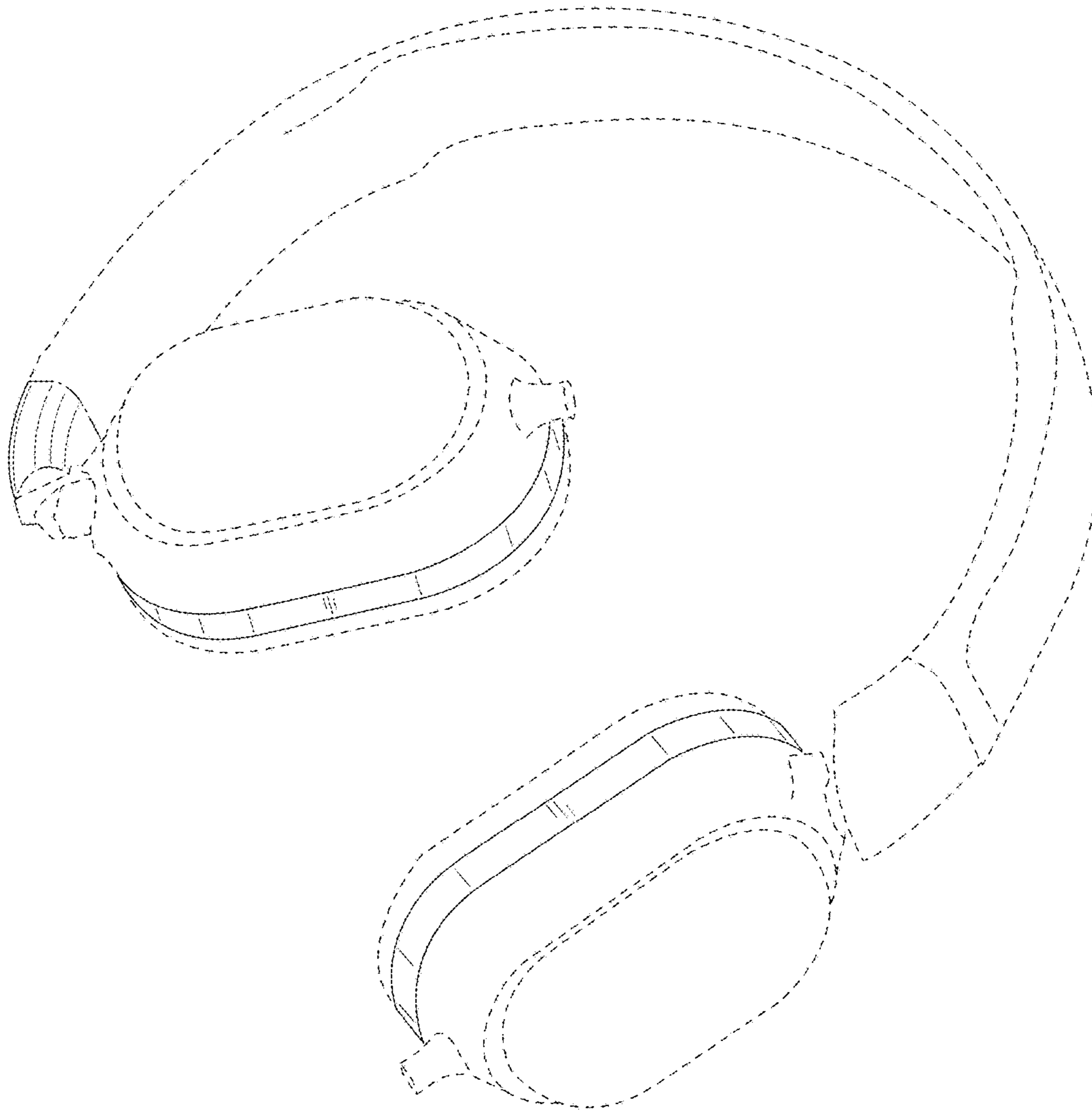


FIG.25

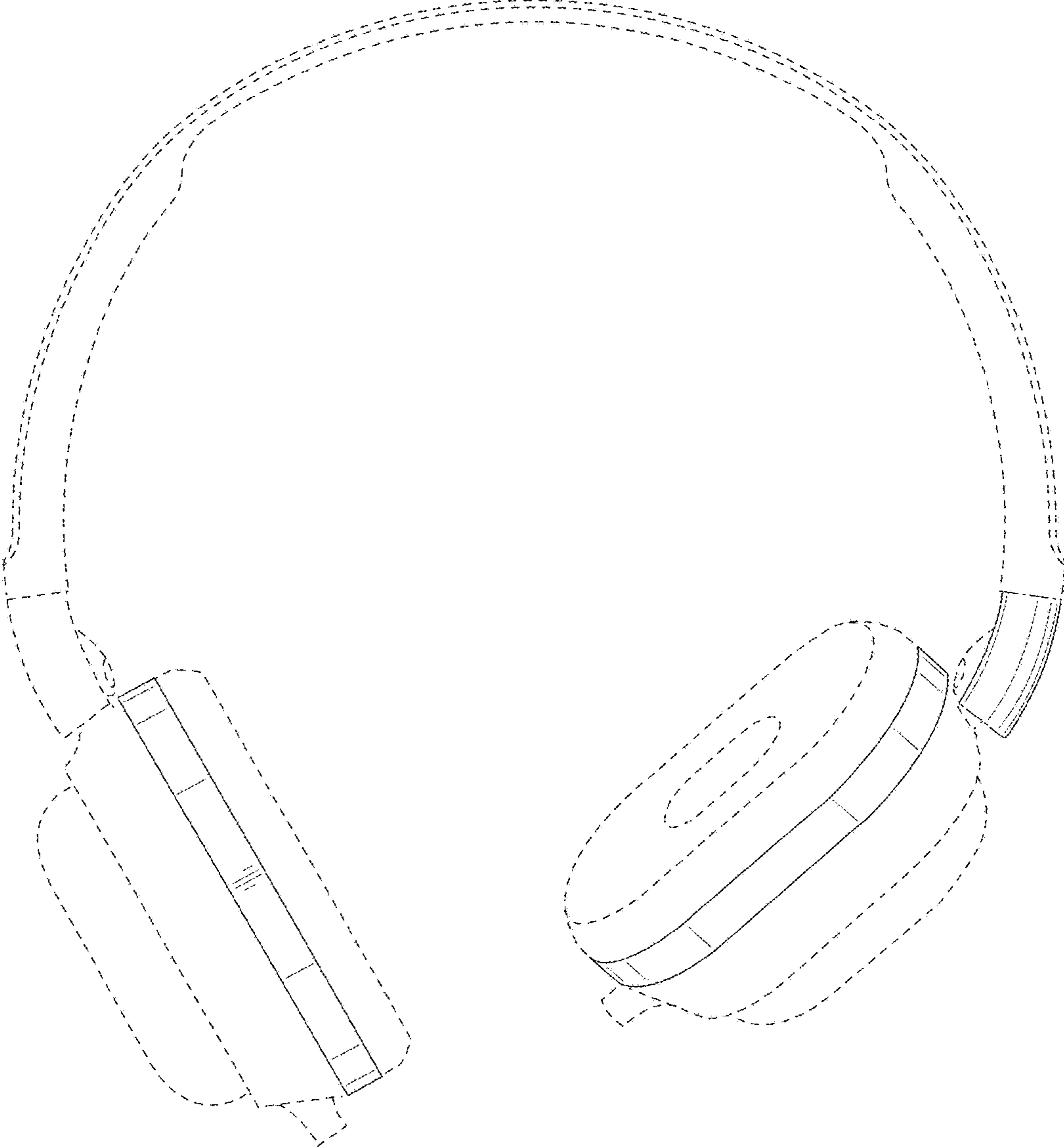


FIG.26

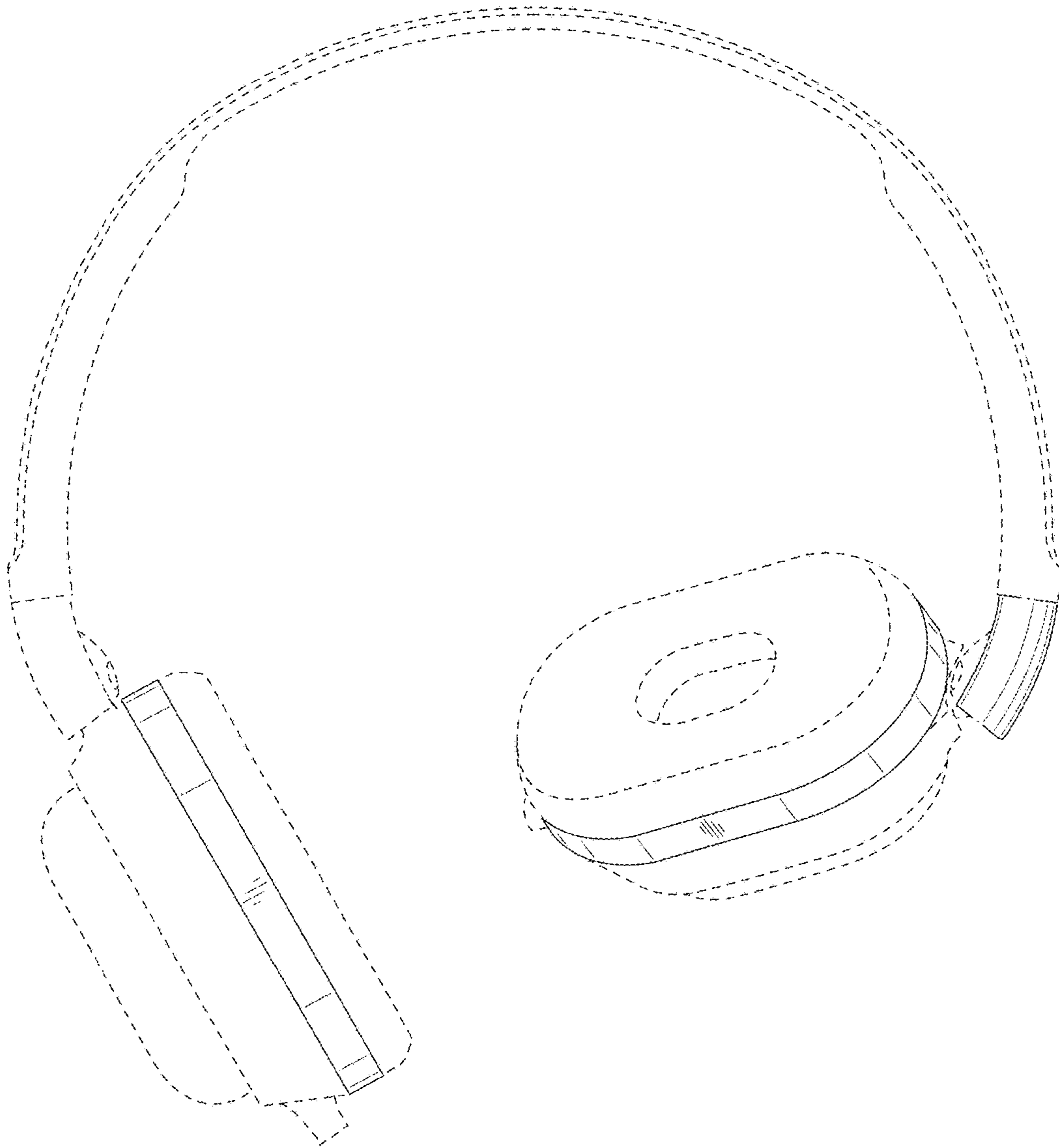


FIG.27

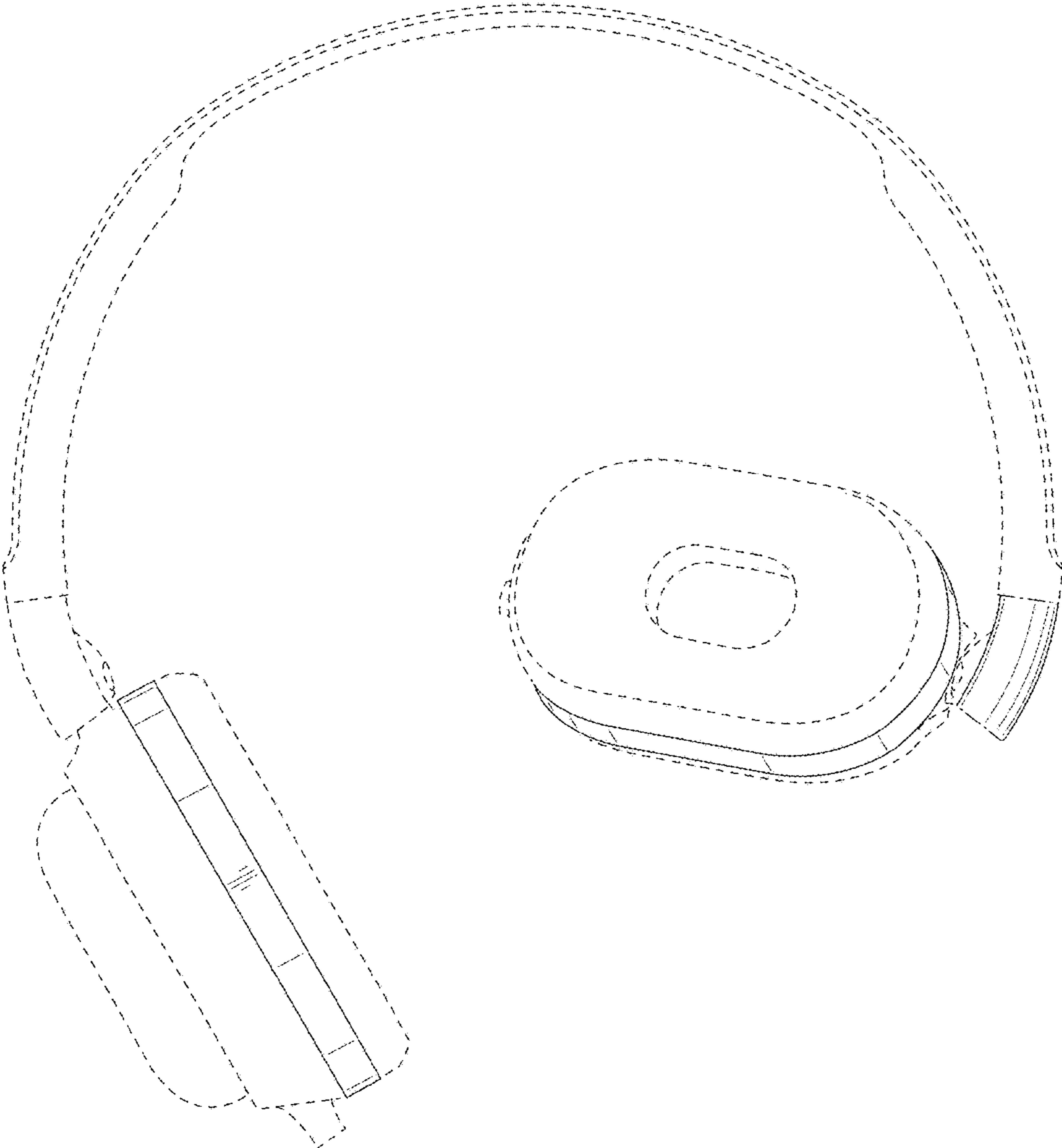


FIG.28

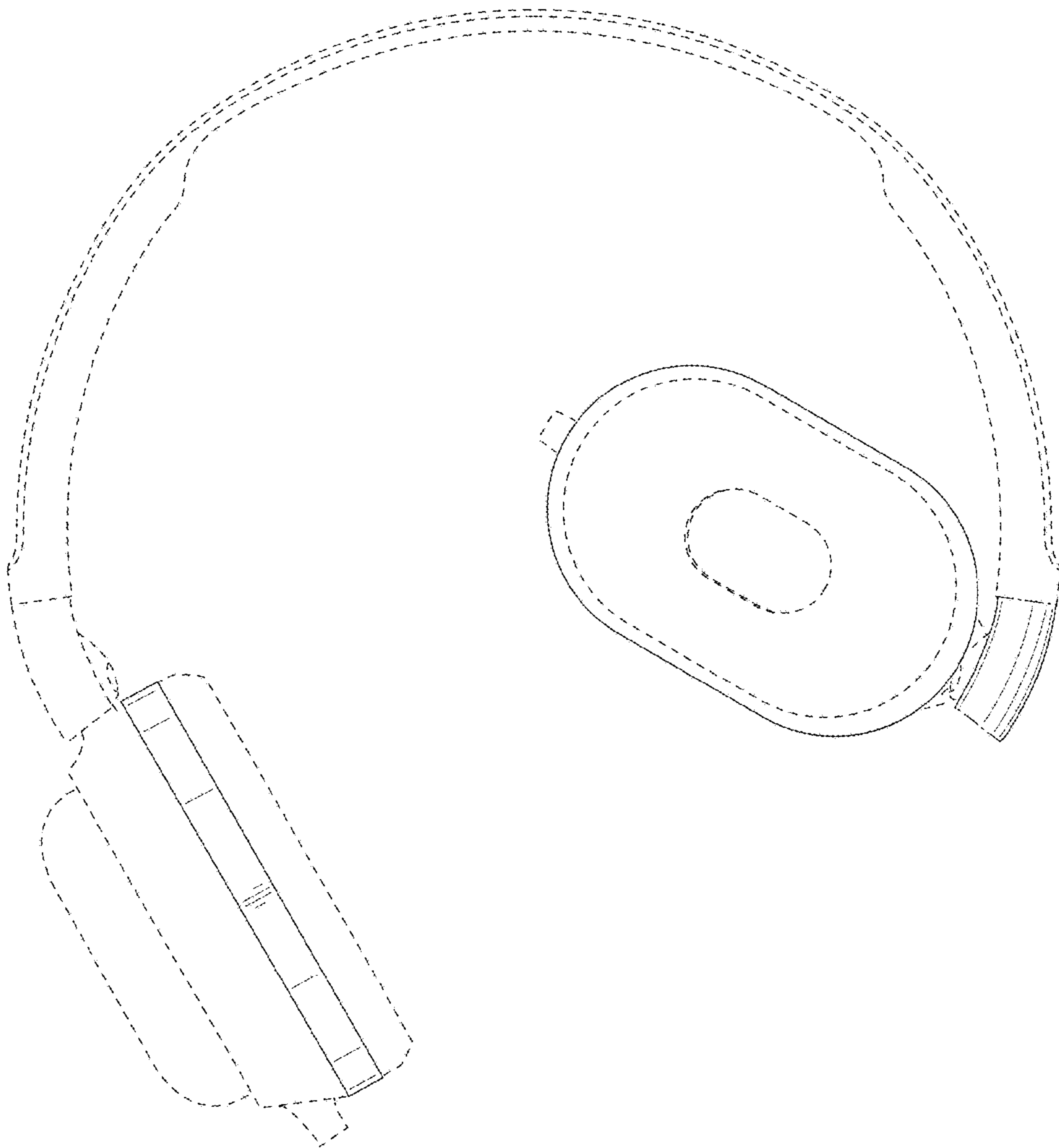


FIG.29

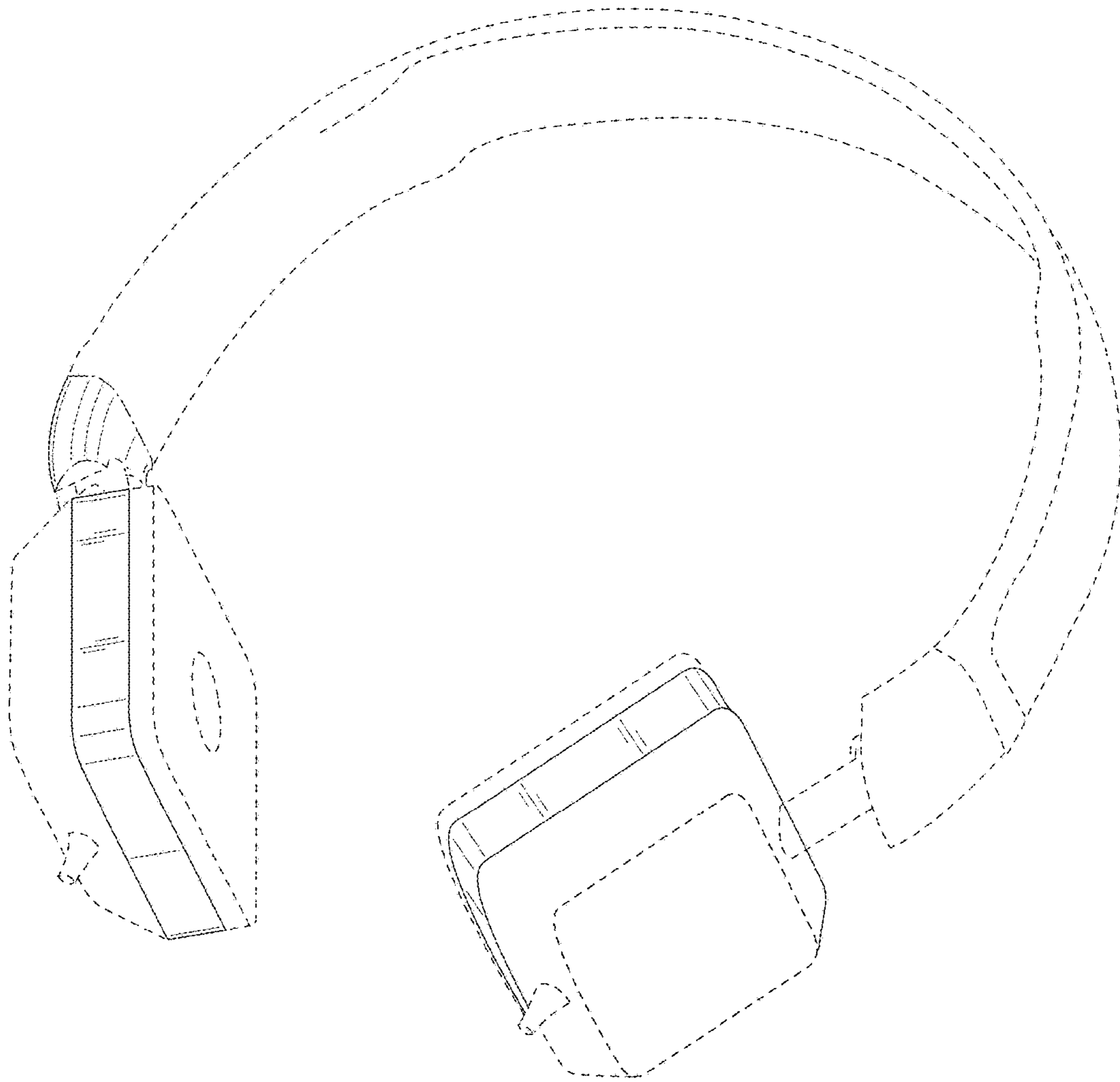


FIG.30

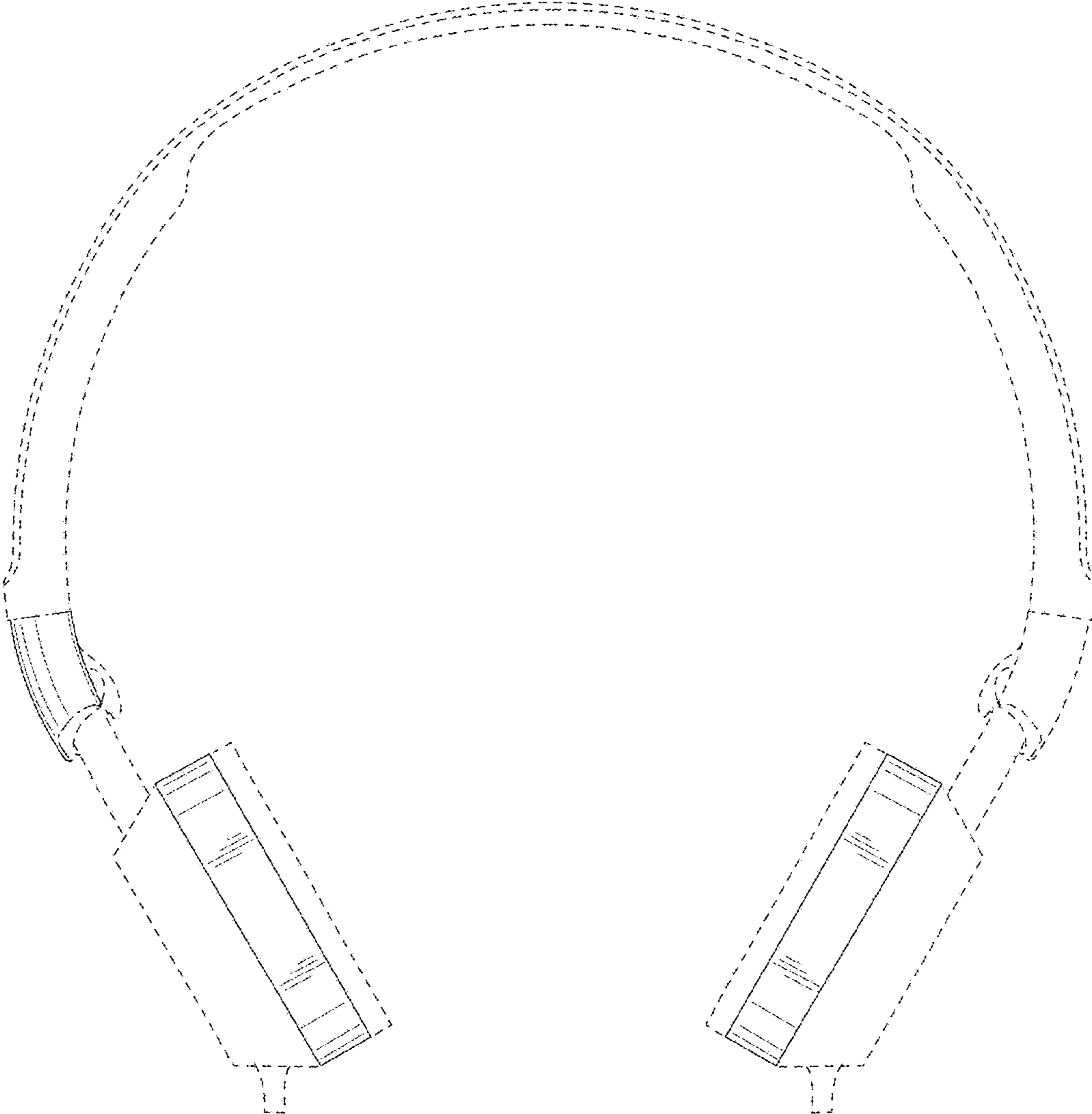


FIG.31

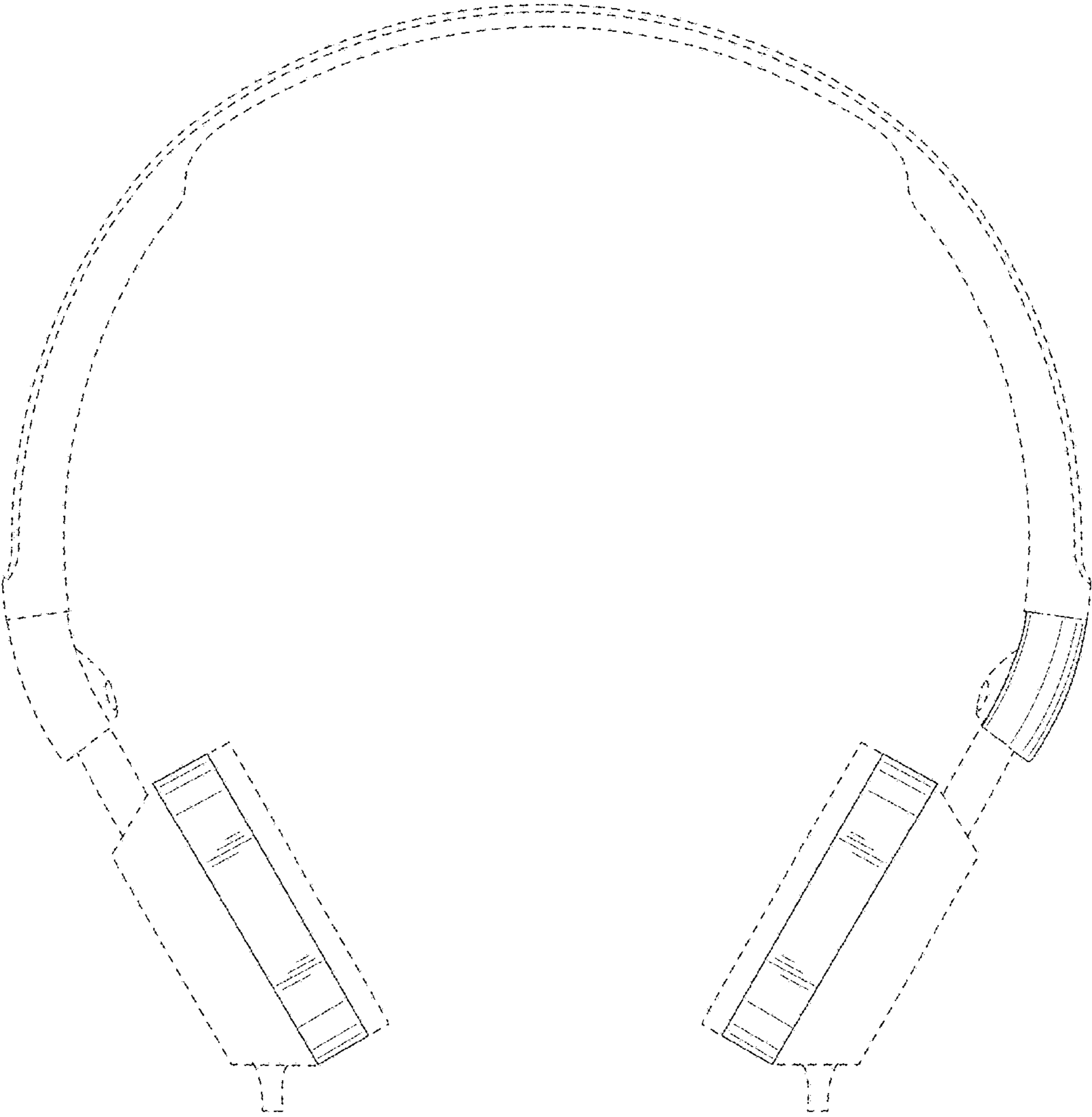


FIG.32

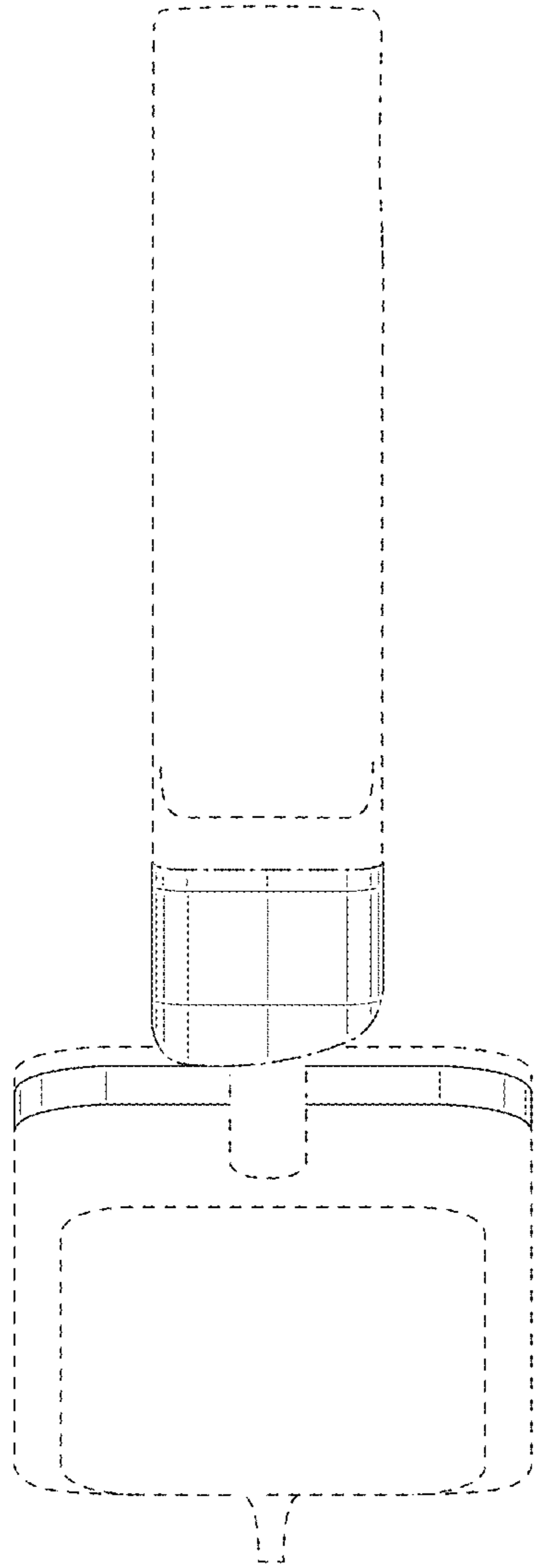


FIG.33

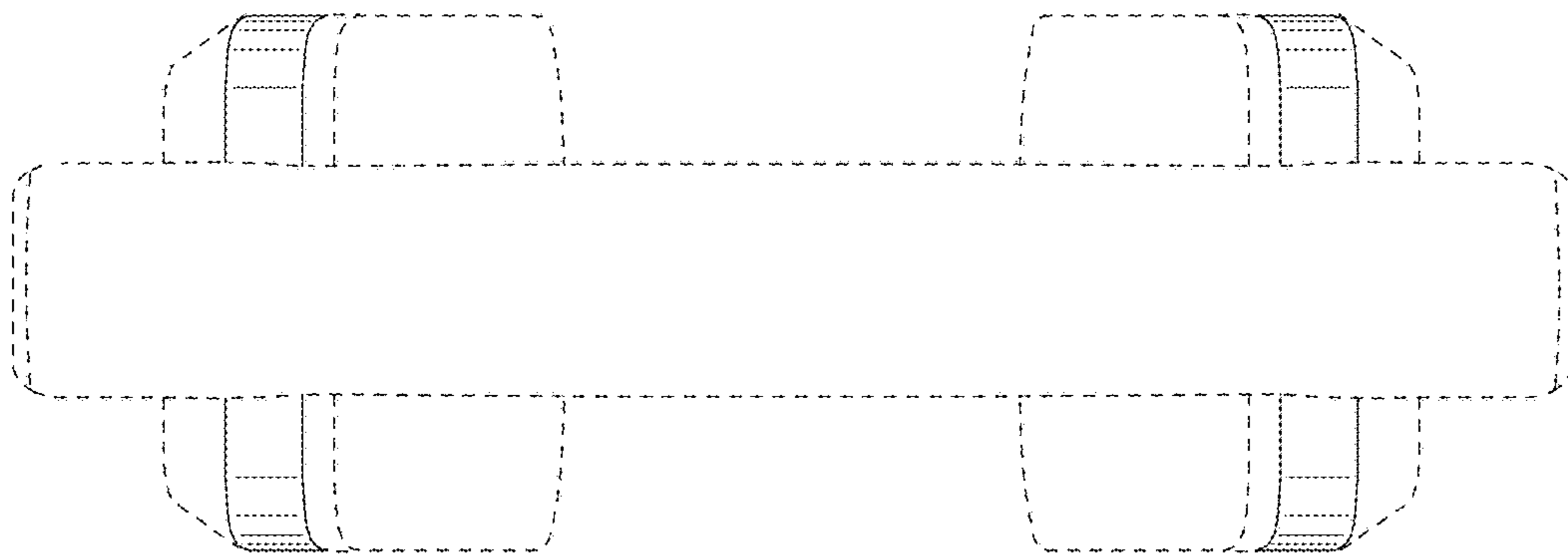


FIG.34

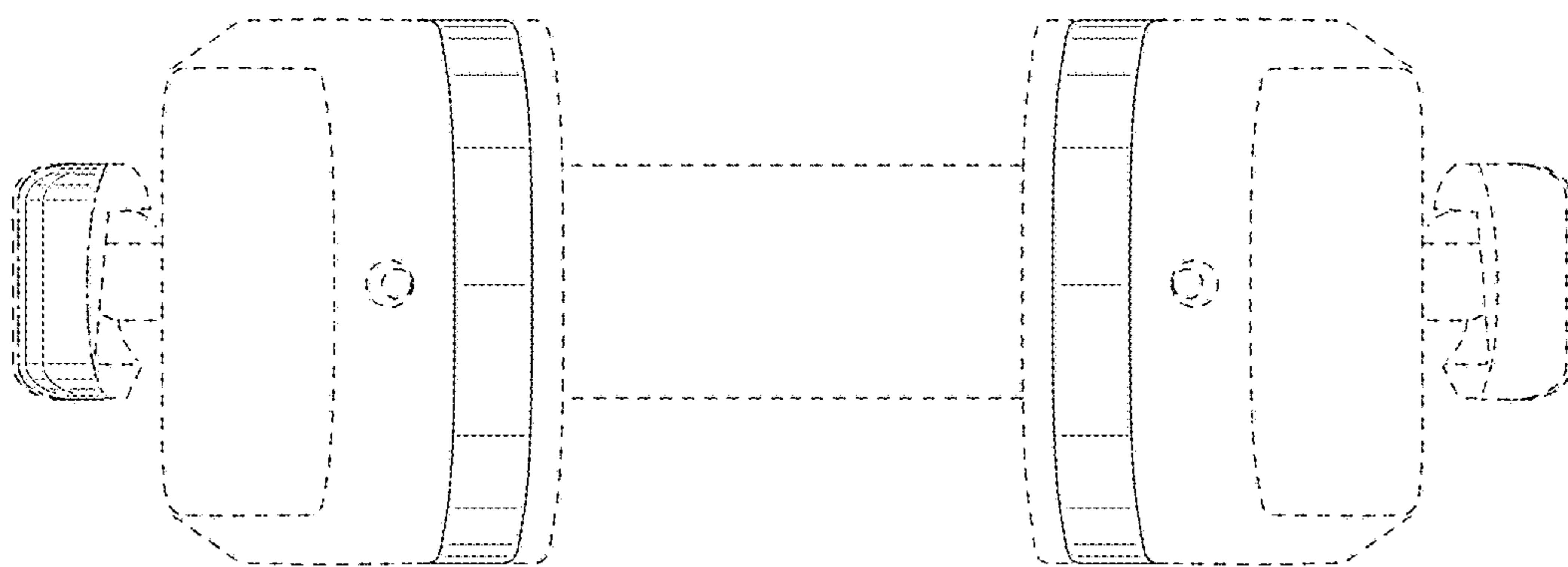


FIG.35

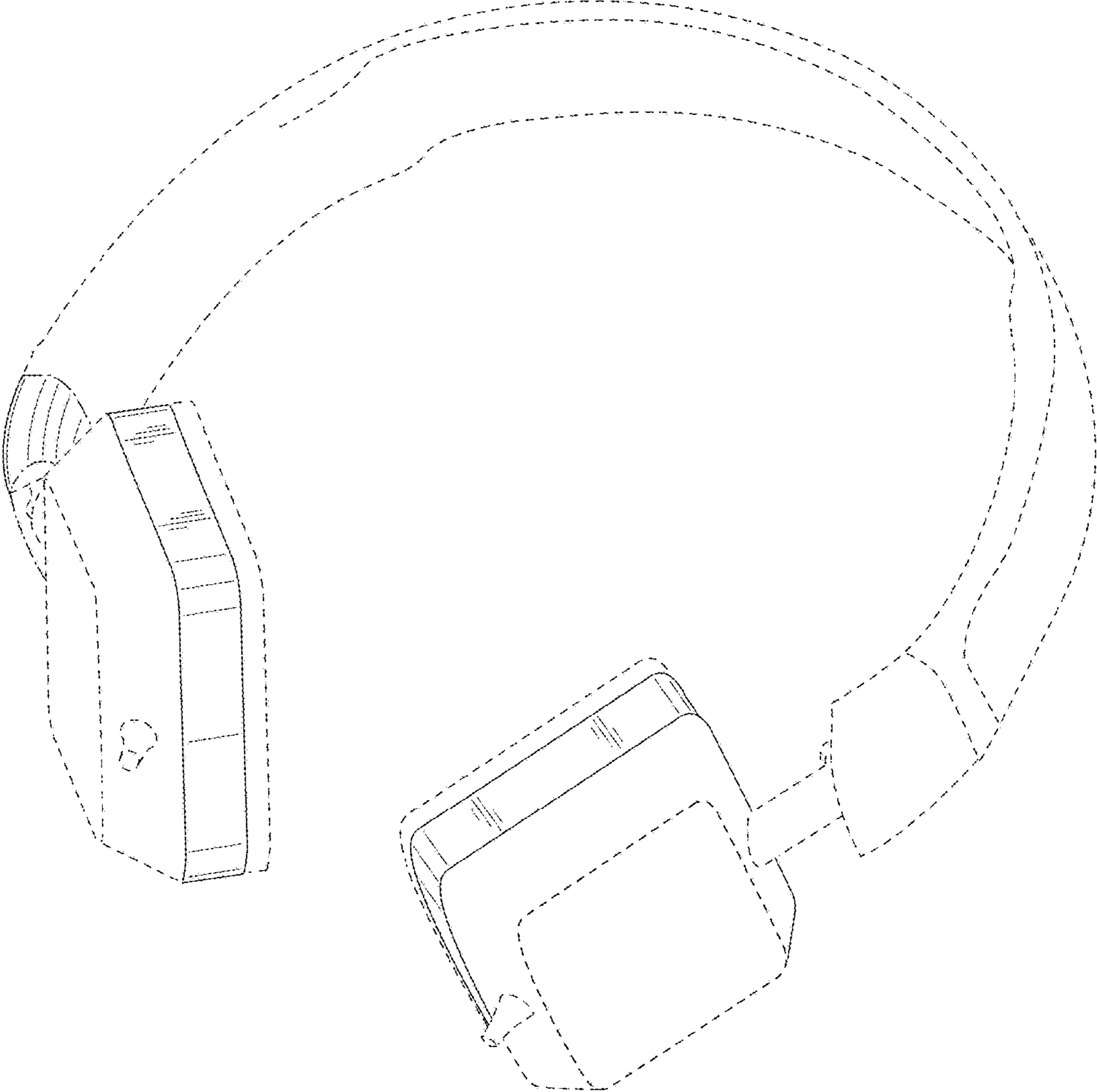


FIG.36

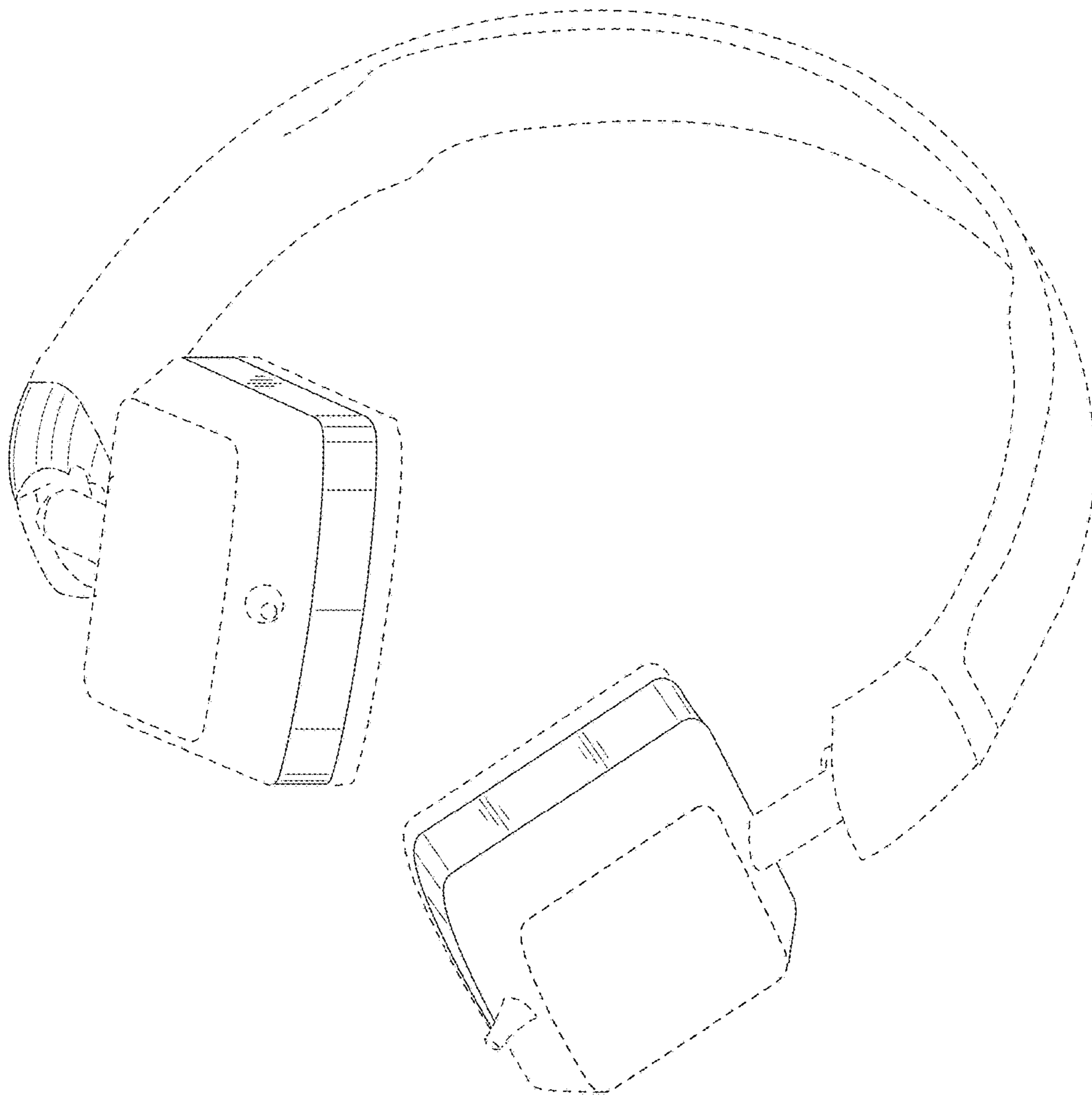


FIG.37

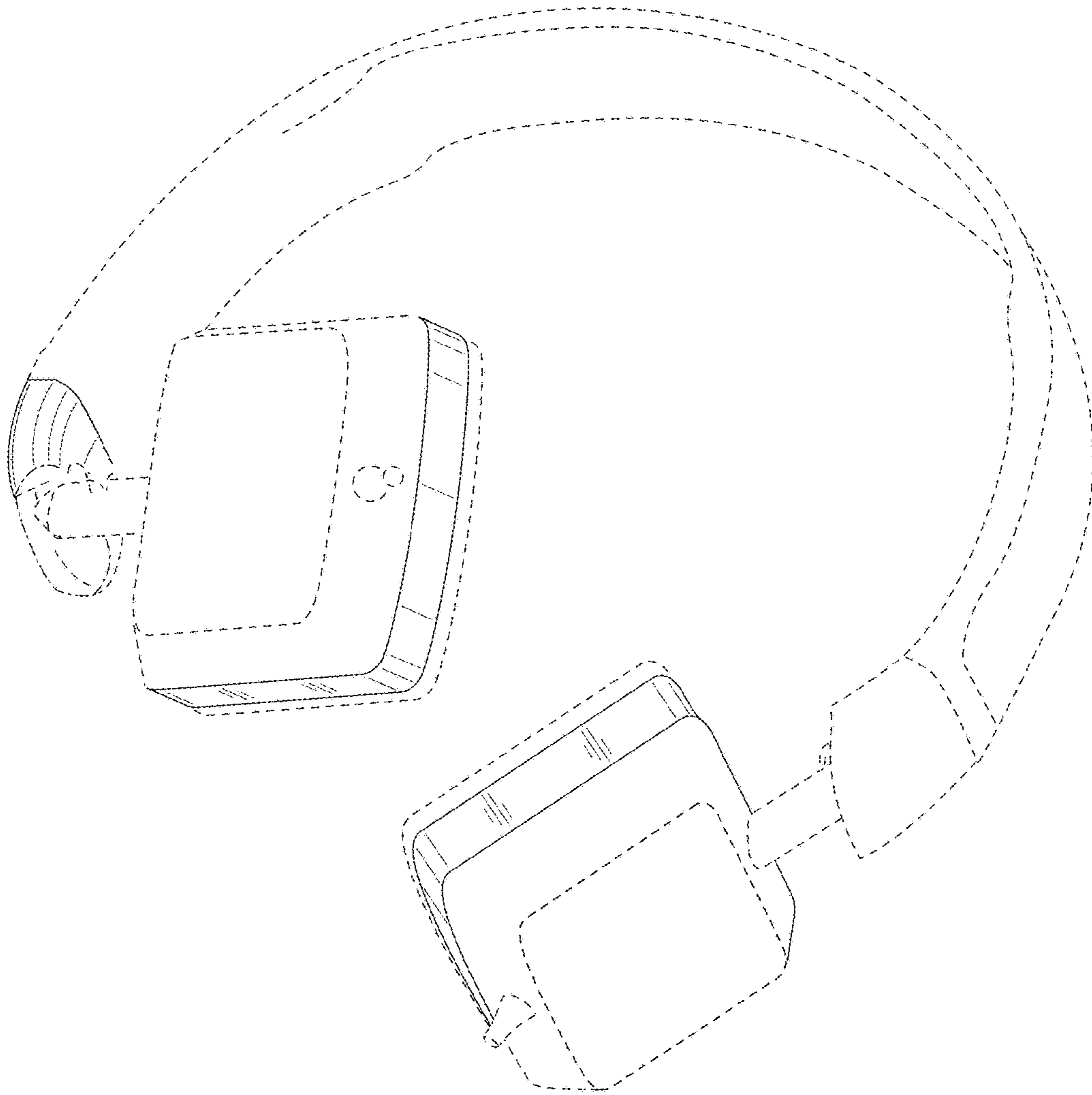


FIG.38

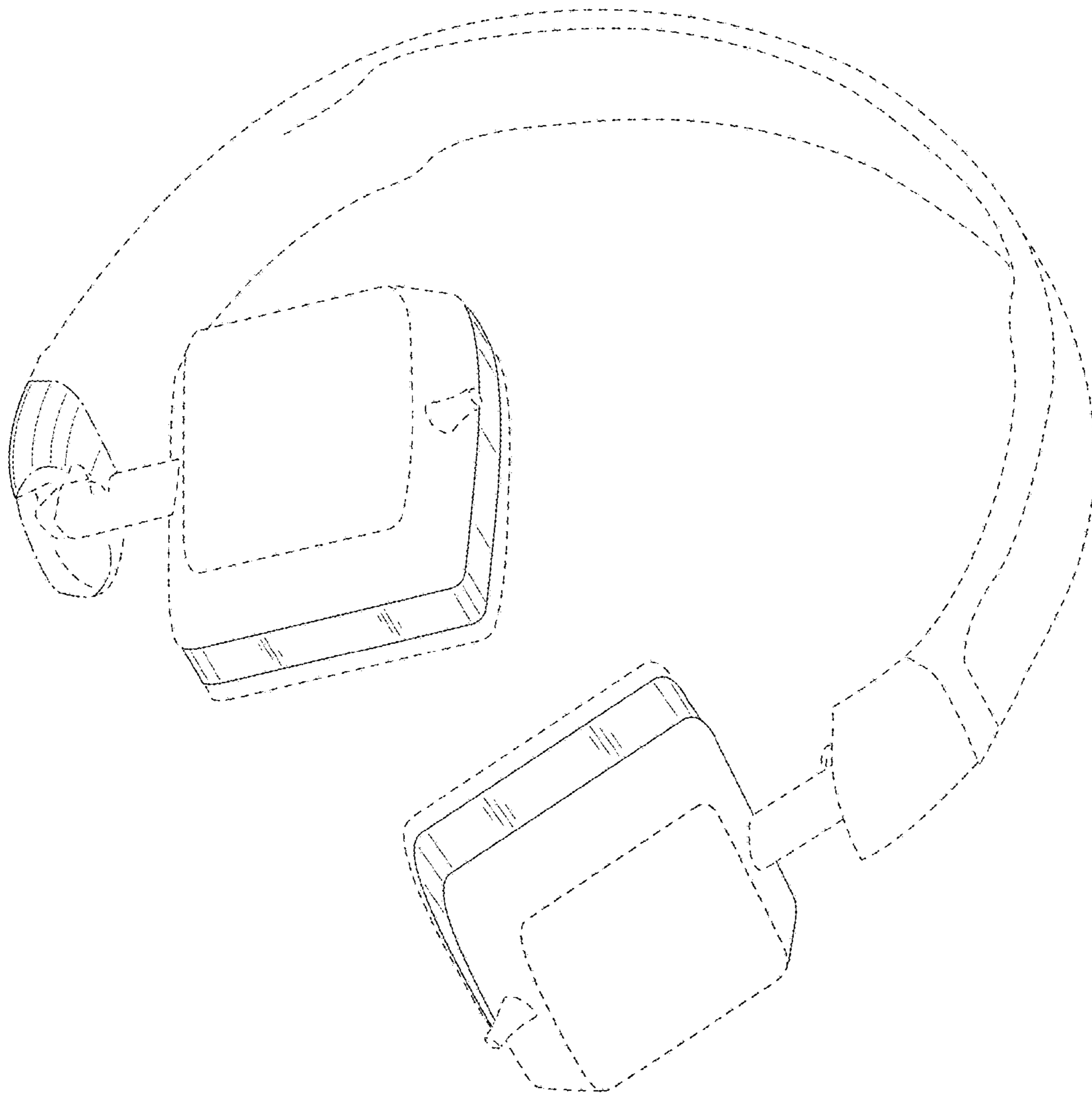


FIG.39

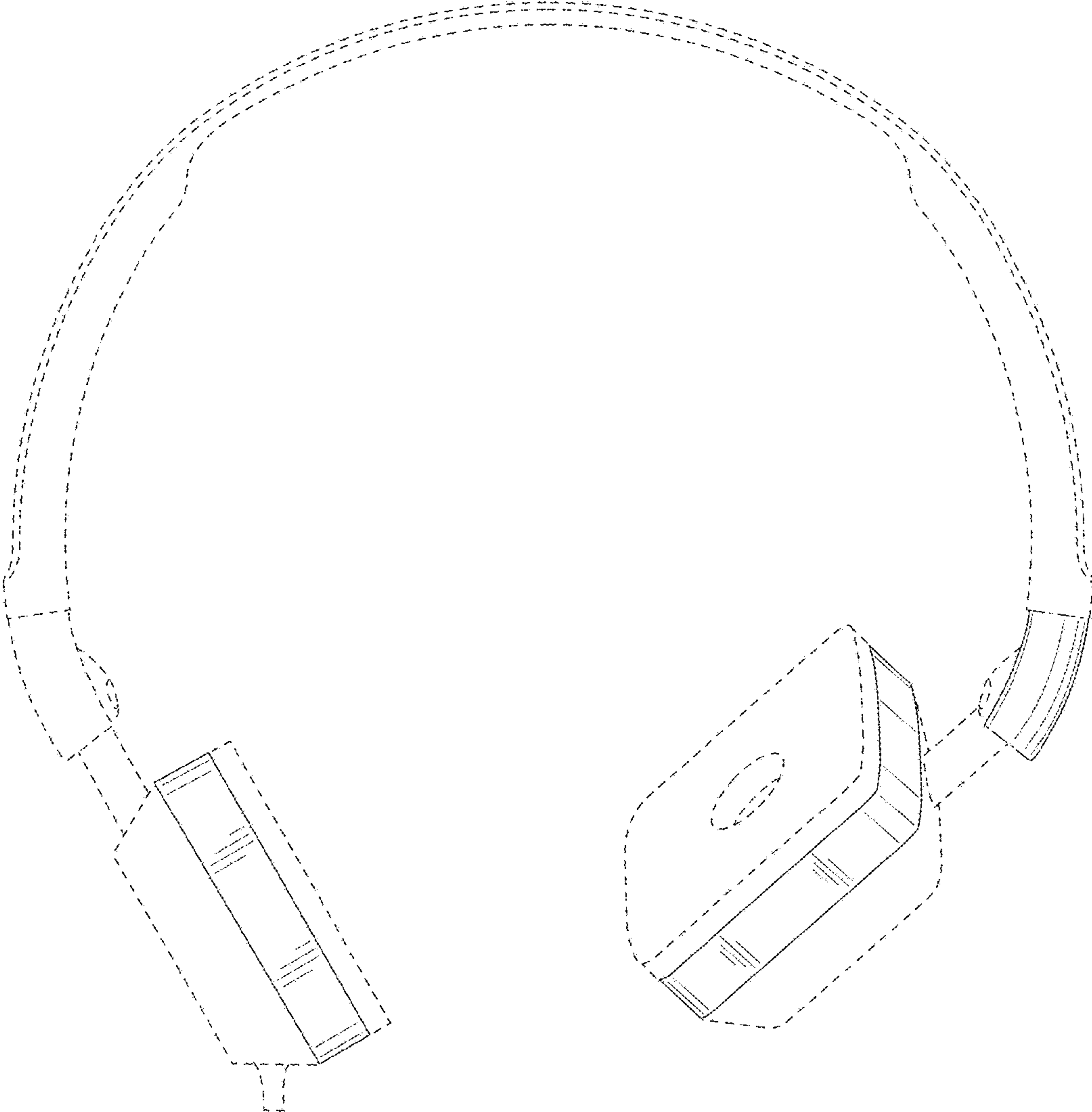


FIG.40

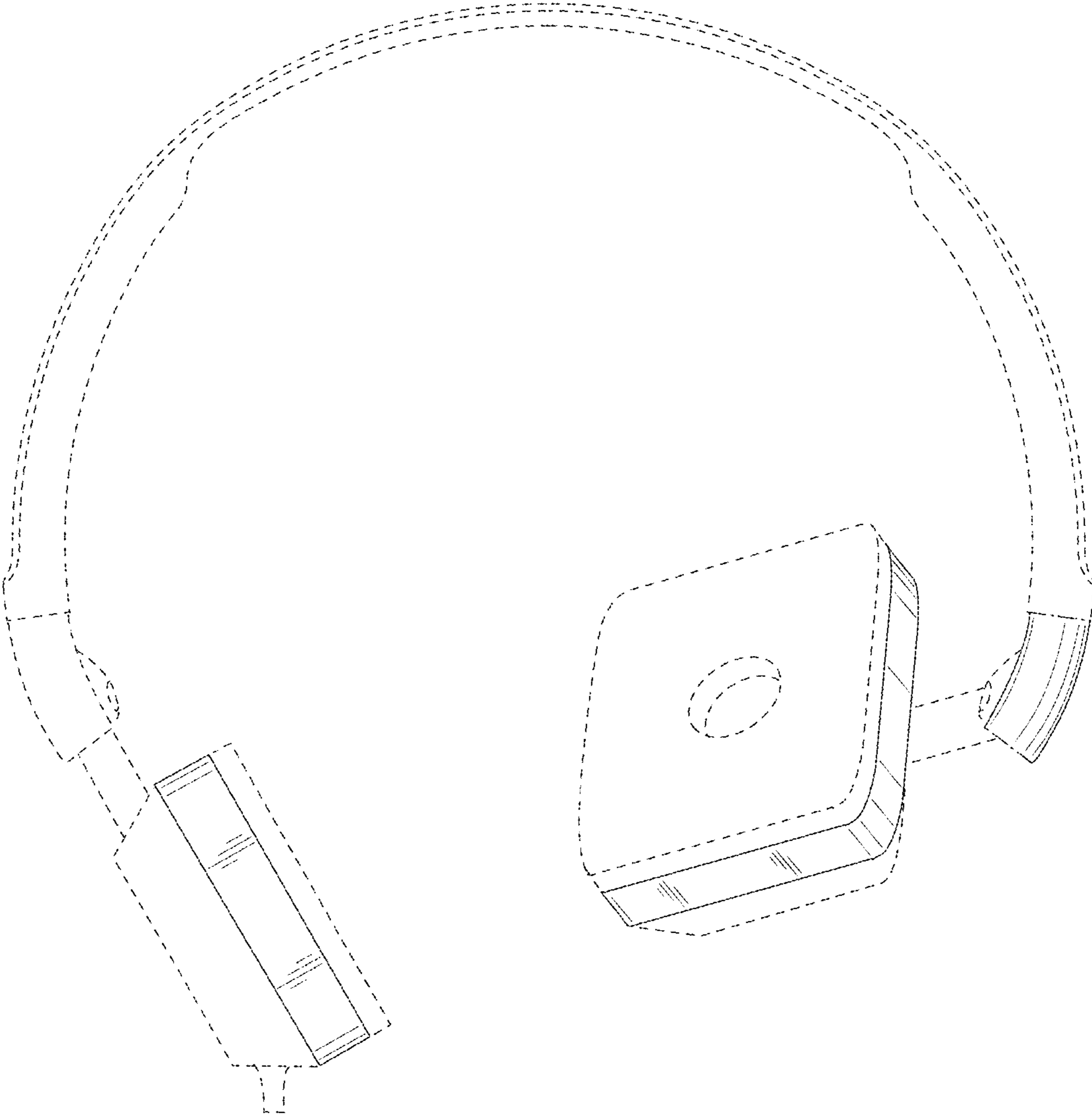


FIG.41

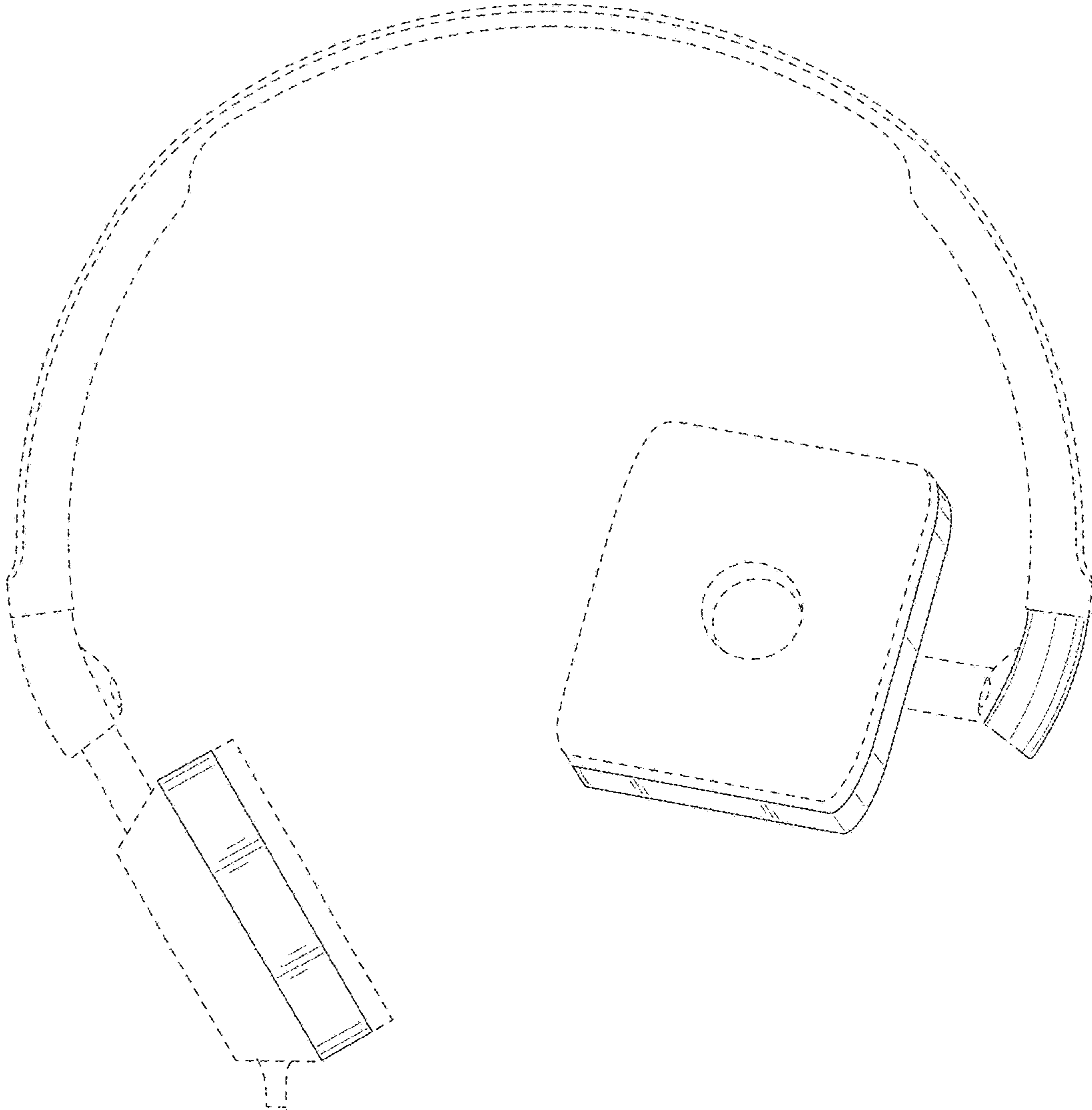


FIG.42

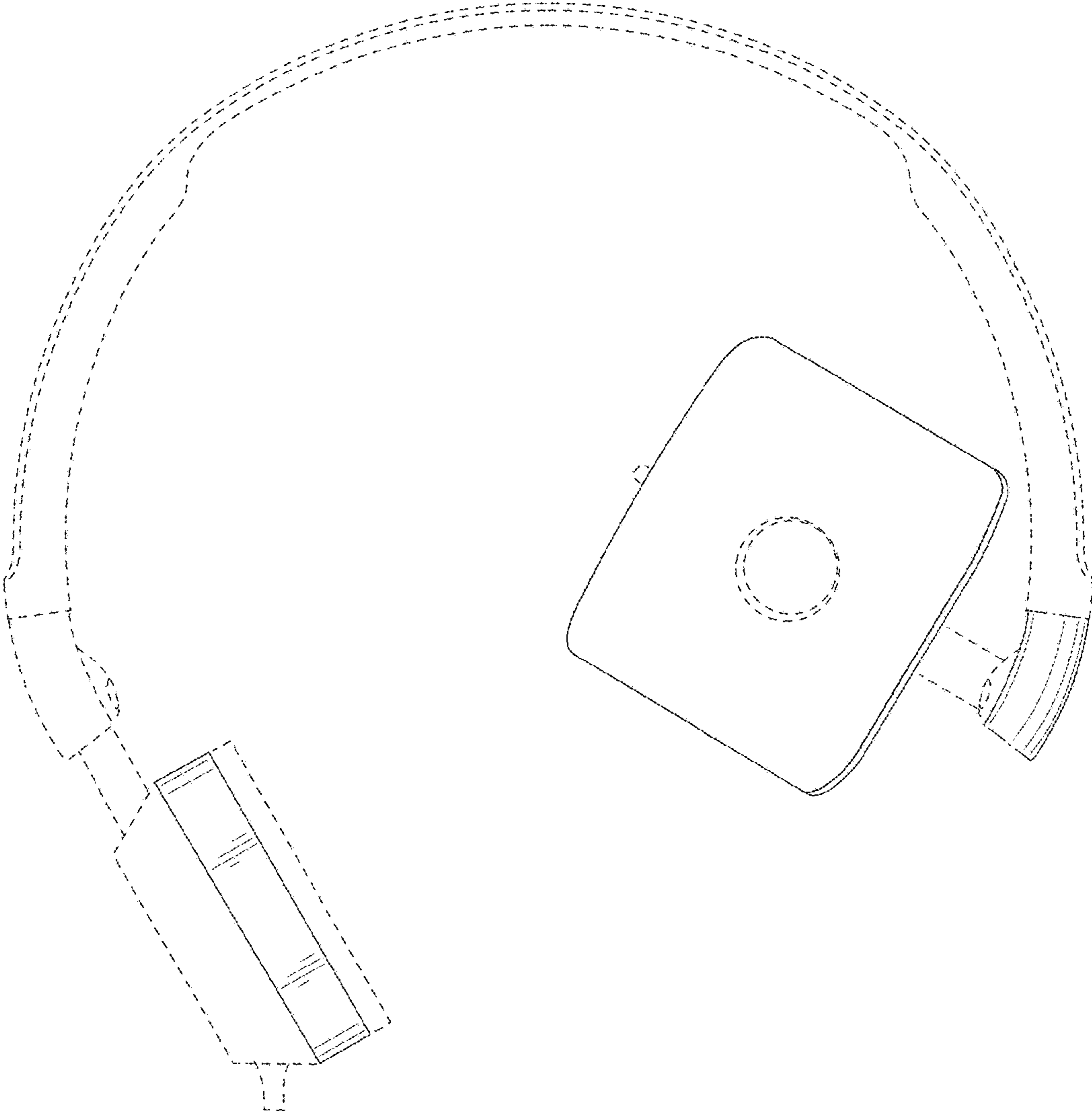


FIG.43

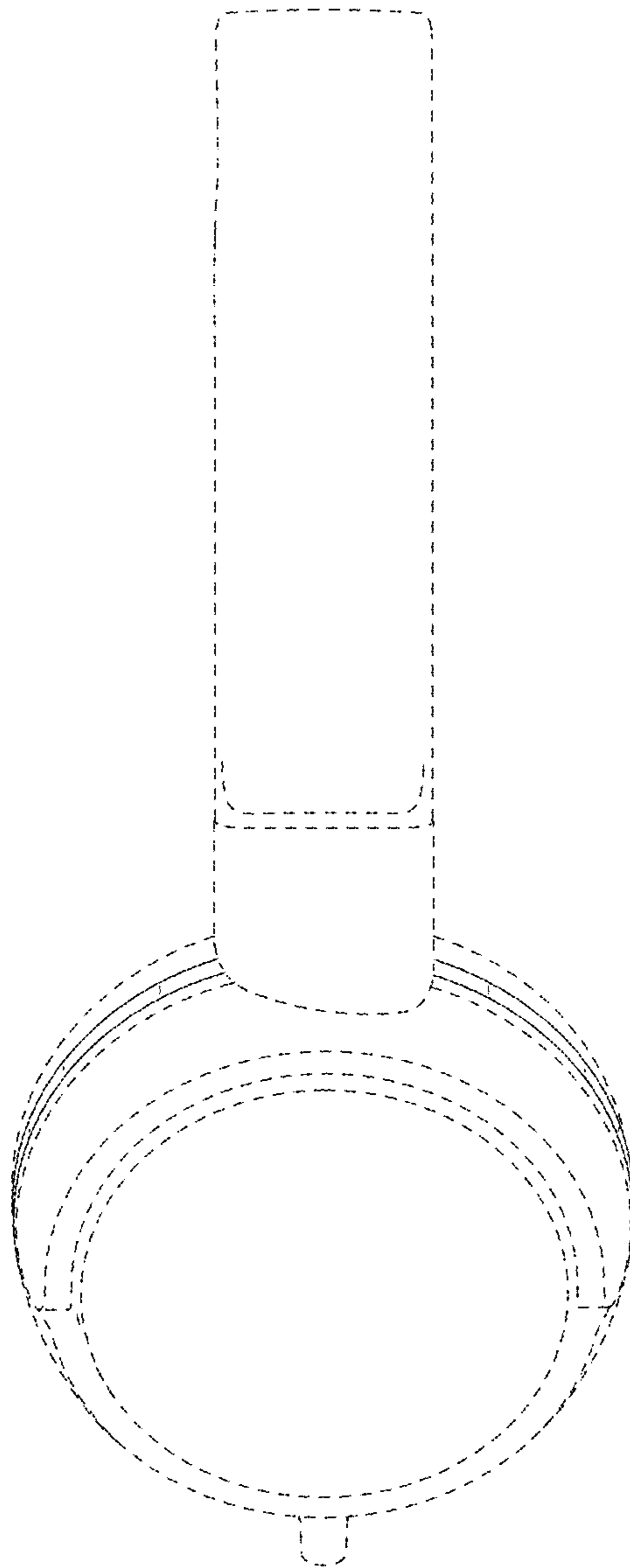


FIG.44

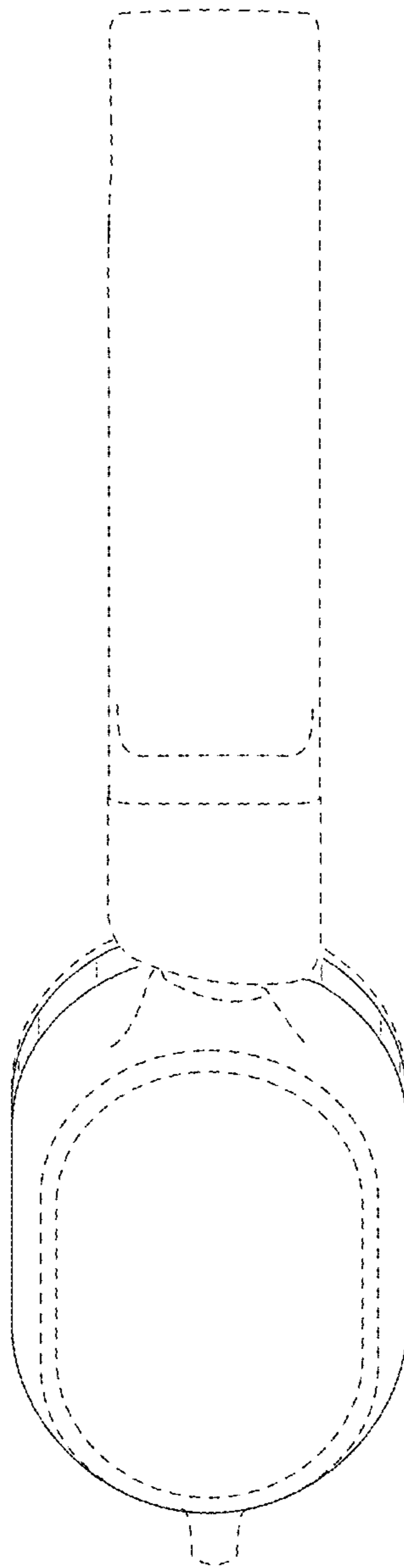


FIG.45

